

# Understanding and Pushing the Limits of Critical Current in Coated Conductors

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Steve Foltyn, Leonardo Civate

Focus: Investigating thickness dependence of  $J_c$

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Honghui Zhou, Yuan Li, Scott Baily

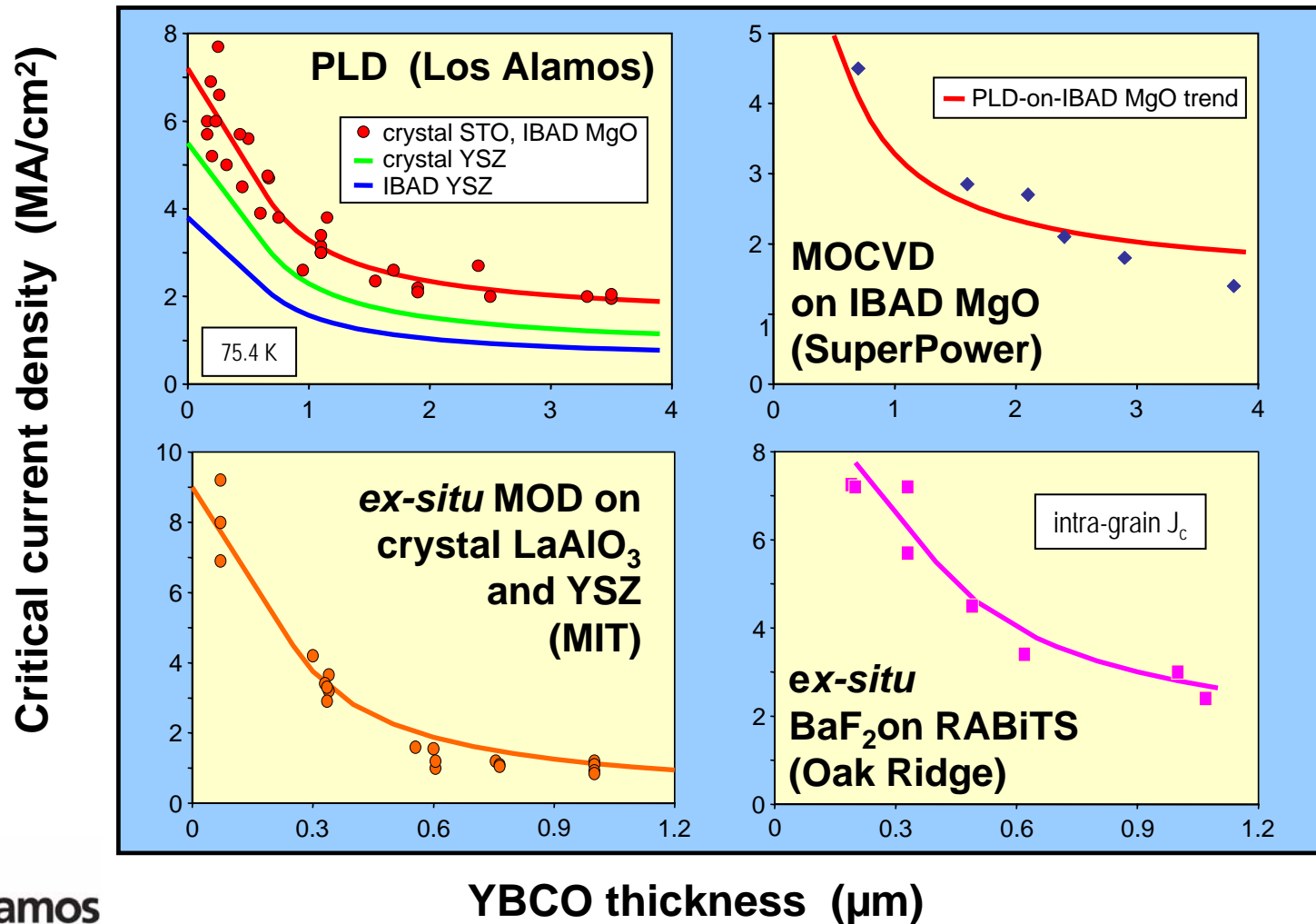
*Superconductivity Technology Center  
Los Alamos National Laboratory*

FY 2006 Project Cost: \$500k

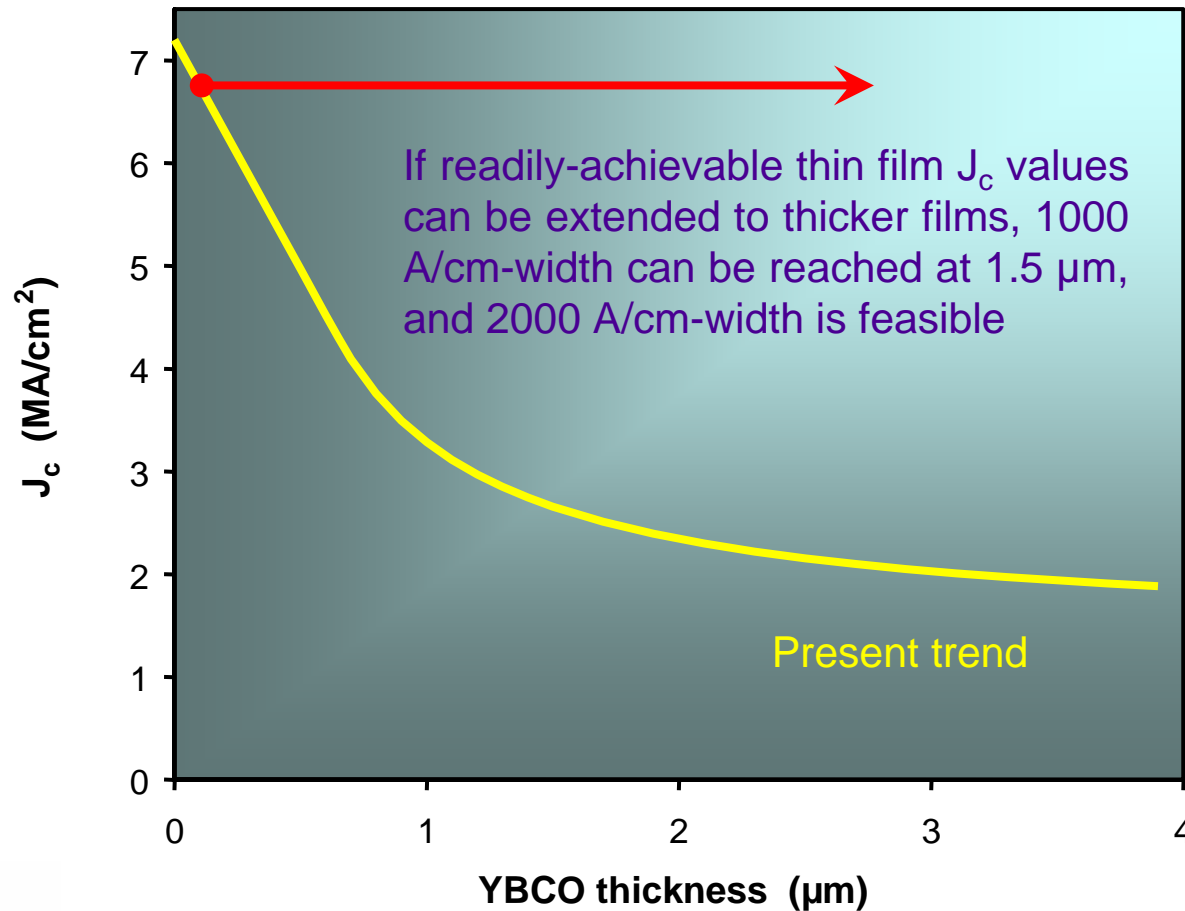
Next talk: Boris Maiorov

"Expanding the set of tools for investigating and improving vortex pinning "

# Thickness dependence of $J_c$ can be strikingly similar for a variety of different deposition processes



# The motivation for understanding and controlling thickness dependence is clear



# Three models have been proposed to explain thickness dependence

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- \* **Intrinsic physics:**  $J_c$  is fundamentally related to film thickness through a mechanism such as the Lorentz force growing faster than the pinning force as thickness is increased.
- \* **Microstructural decay:** The high quality typical of thin films cannot be maintained in thicker films, so  $J_c$  decreases with thickness.
- \* **Interfacial enhancement:** Film properties near the substrate differ from those far from the interface in such a way that  $J_c$  is higher near the interface.

# We will present a summary of existing evidence plus new evidence supporting the third model

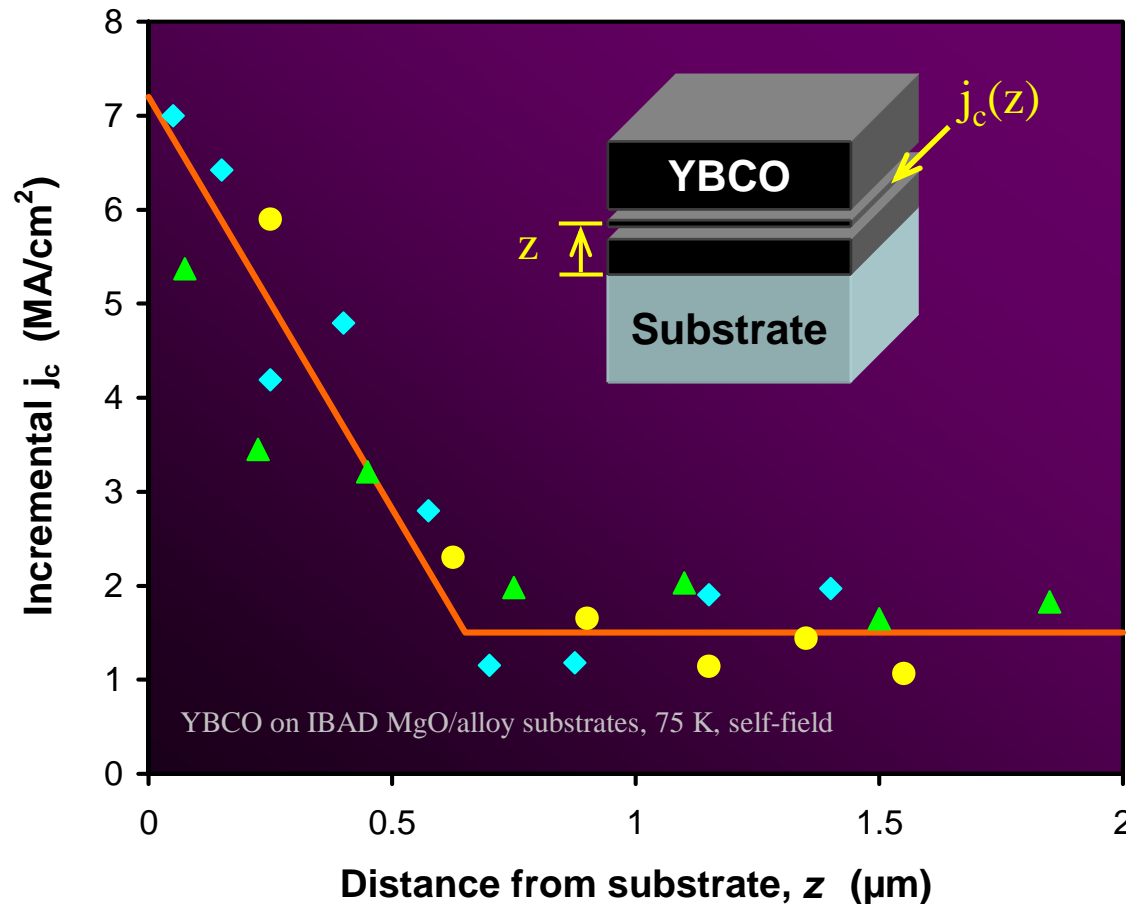
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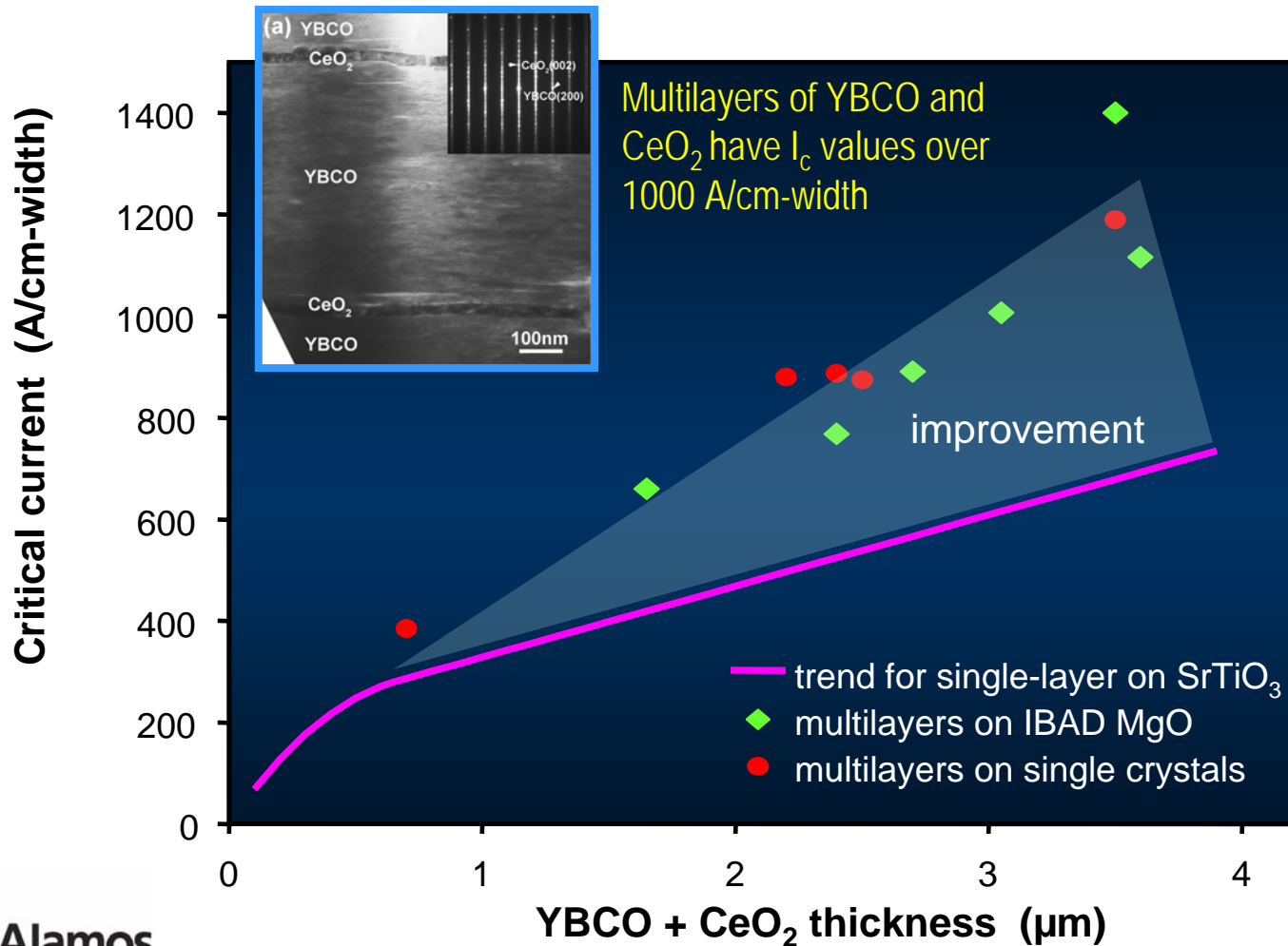
We first described the interfacial enhancement model at the 2004 Peer Review. Since that time we have developed conclusive evidence that it correctly explains high  $J_c$  in thin films and the rapid drop as thickness is increased.

We developed the interfacial enhancement model after evaluating the incremental variation of  $J_c$  within a film...

Symbols: Result obtained by ion milling three samples.  
Line: Result obtained by fitting to  $J_c(t)$  curve.

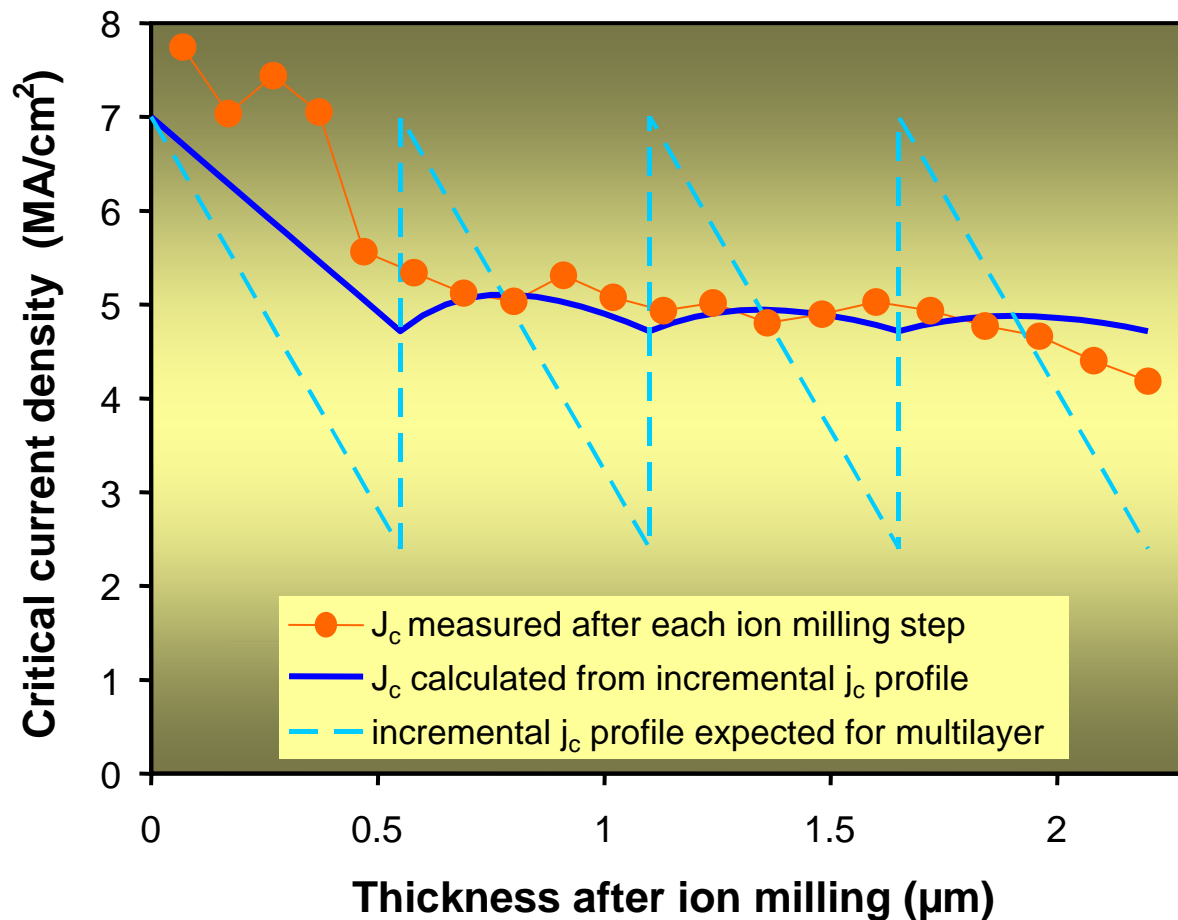


...and this idea suggests that additional interfaces will enable high  $J_c$  in thick films...



...by periodically reproducing interfacial enhancement throughout the entire film

Ion milling of multilayer with 4 YBCO layers is consistent with expectations



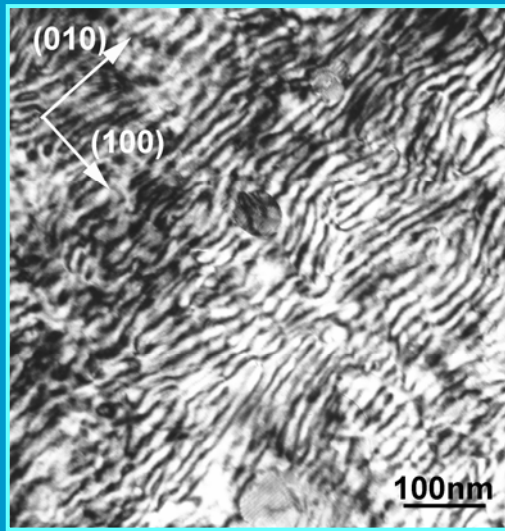
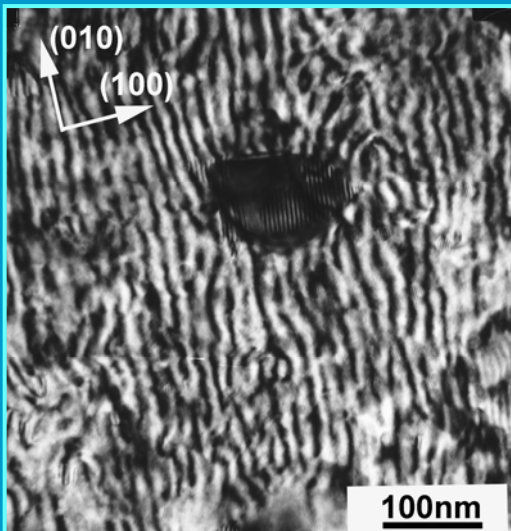


# We then began a series of experiments aimed at testing the interfacial enhancement hypothesis

**Experiment :** Search for something different about the interfacial region.

**Result :** Found evidence for misfit dislocations originating at the interface.

**TEM plan views of a ~ 20 nm thick YBCO film on a  $\text{SrTiO}_3$  single-crystal substrate**



**Misfit between  
 $\text{SrTiO}_3$  lattice and:**

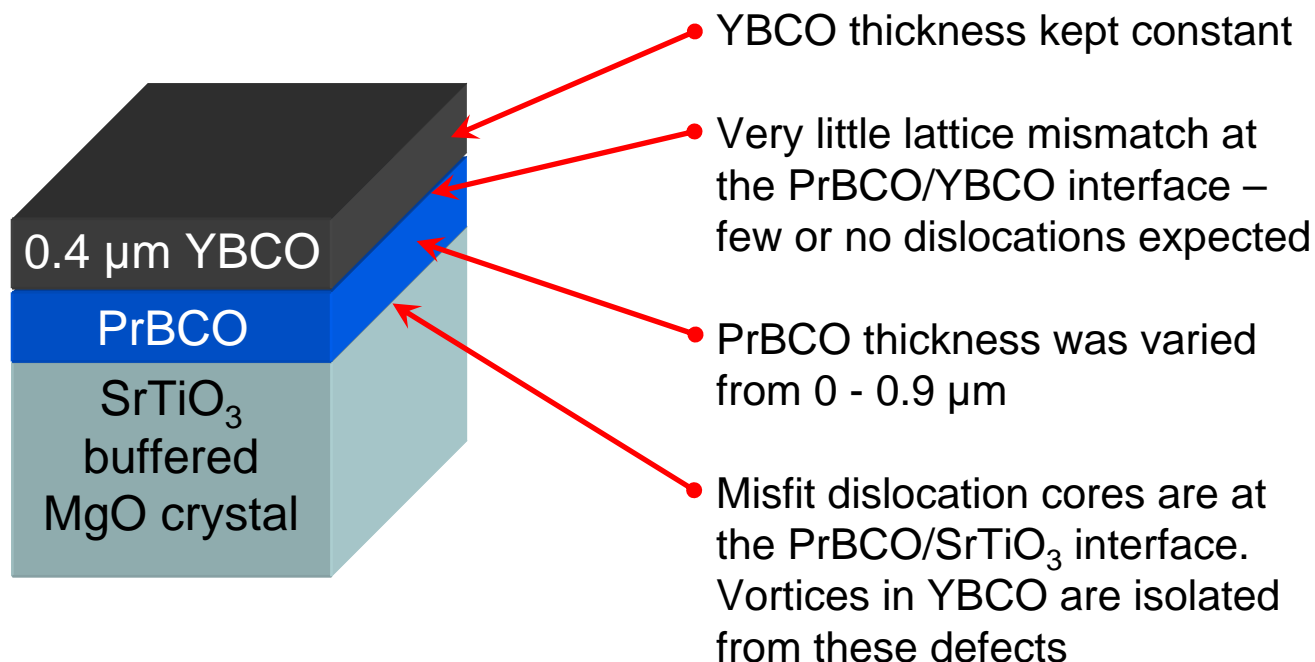
**YBCO a-axis – 2.4 %**

**YBCO b-axis – 0.7 %**

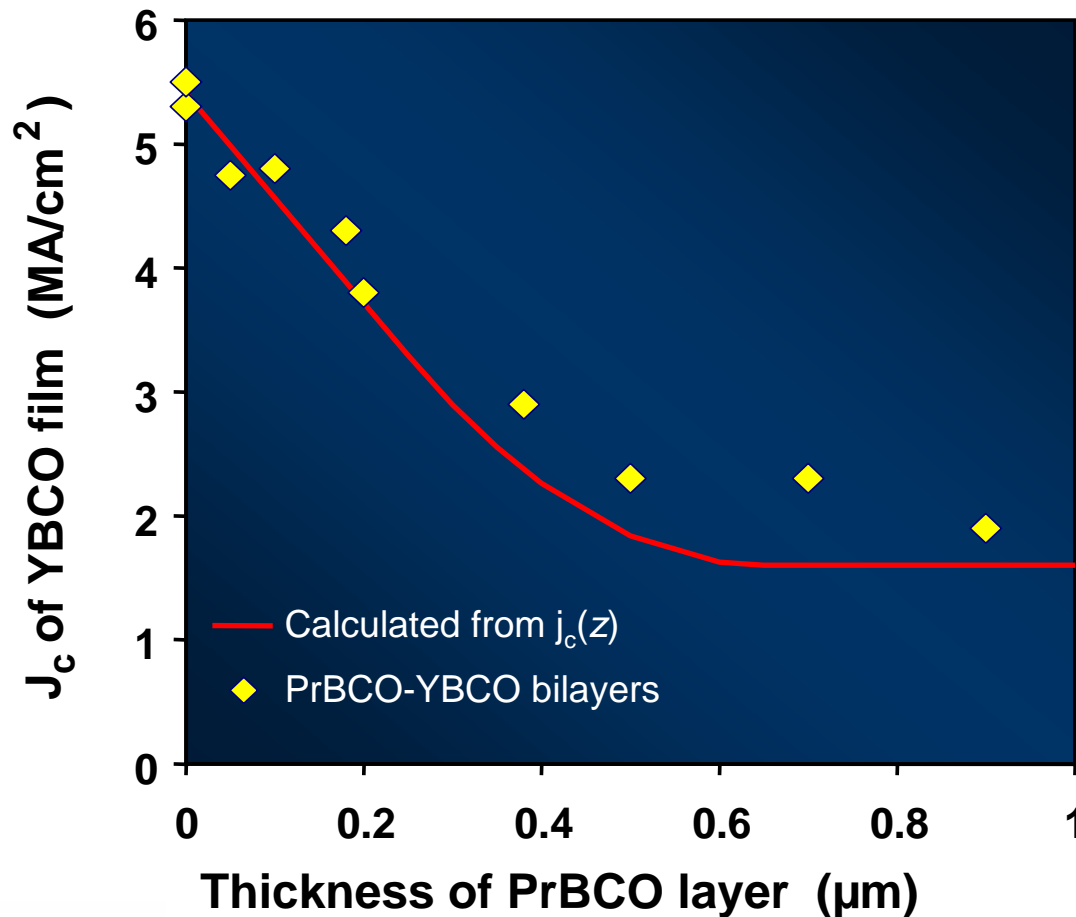
**Spacing of ~ 17 nm  
equals that calculated  
for a-axis misfit**

## We next measured the effect of separating YBCO from the defect-rich interface...

**Experiment:** Deposit YBCO films of constant thickness on PrBCO layers of different thickness to test the effect of moving the superconductor farther from the substrate interface.

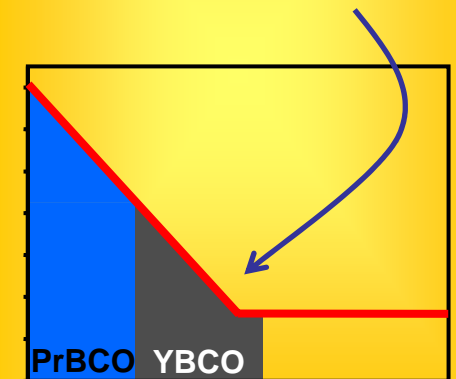


...and found that  $J_c$  depends strongly on the distance between the YBCO layer and the defect-rich interface...

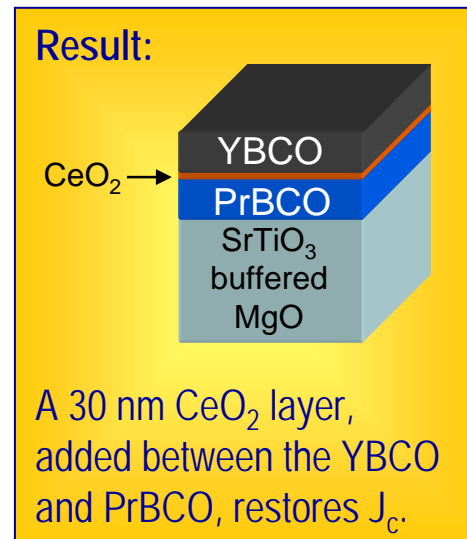
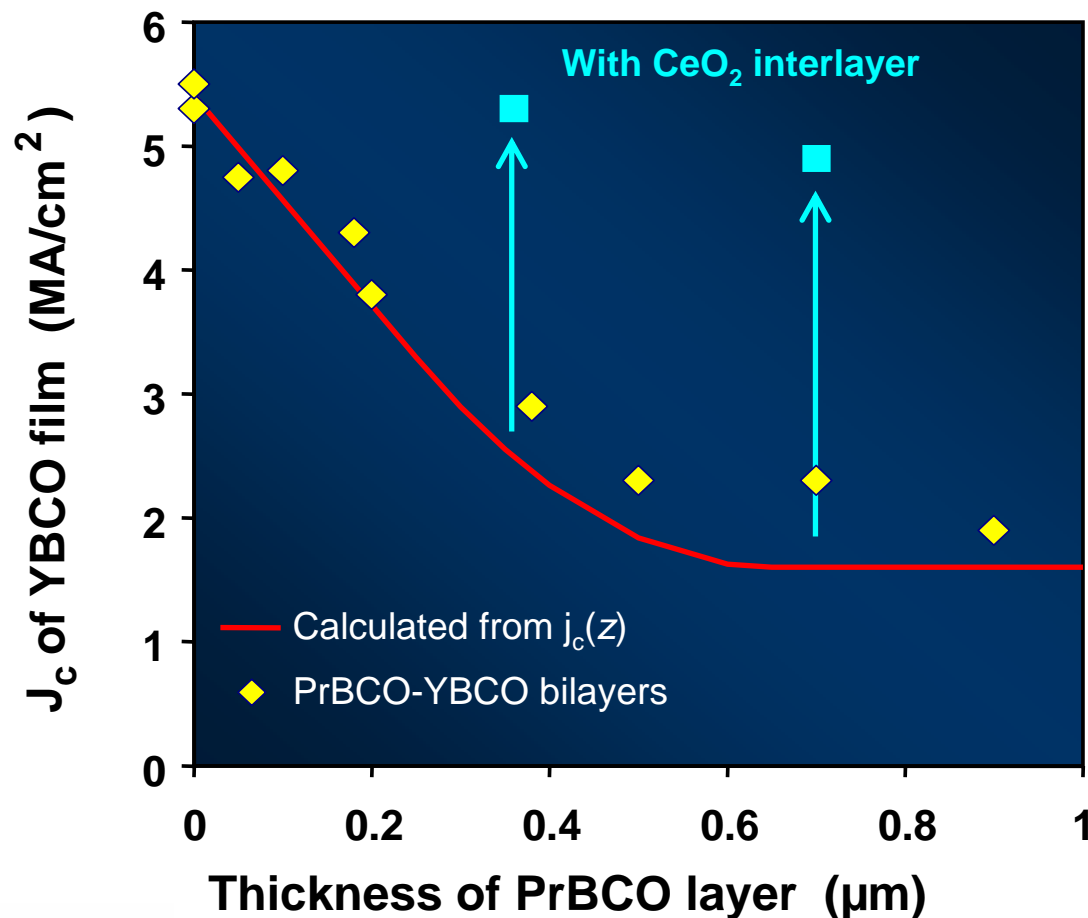


Result :

$J_c$  decreases as the PrBCO layer is made thicker, in agreement with calculation from incremental  $j_c(z)$ .

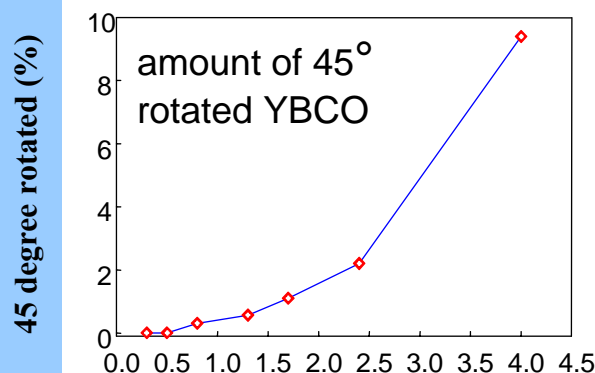
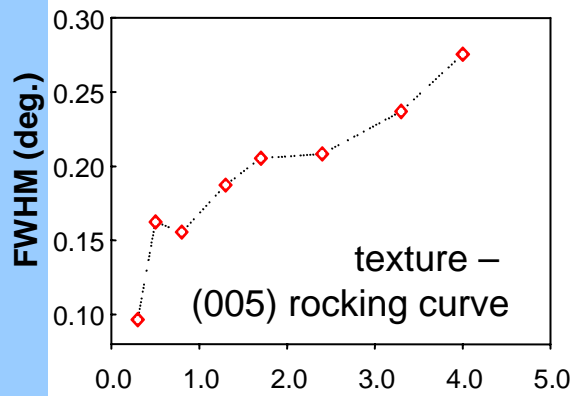


...and that  $J_c$  is restored by adding another defect-rich interface under the YBCO



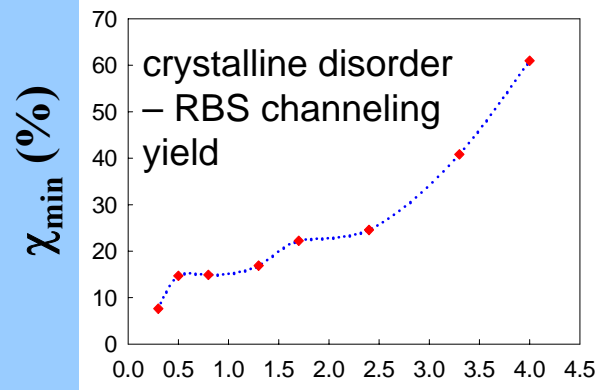
# To evaluate the microstructural decay hypothesis we have measured thickness dependence of several properties

Worse microstructure →



## YBCO on SrTiO<sub>3</sub> substrates

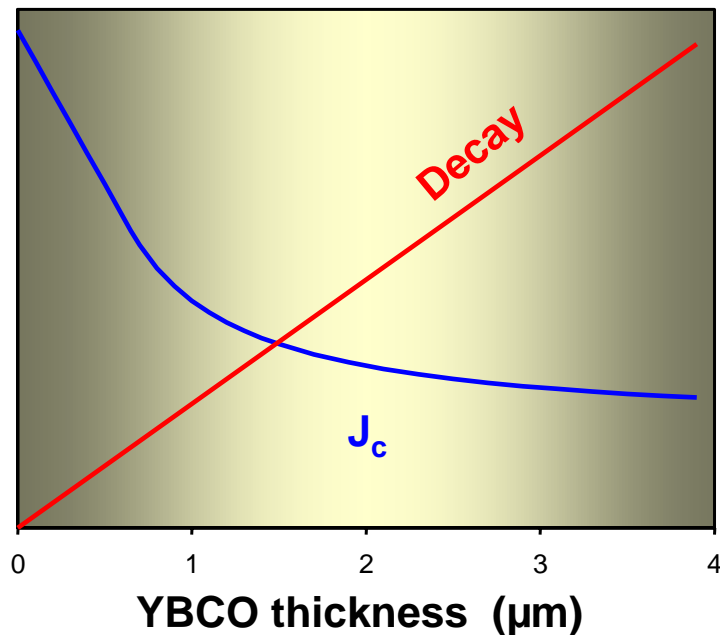
- crystallinity deteriorates as thickness increases
- trend extends over full thickness range
- similar behavior for morphology (roughness, porosity, etc.)



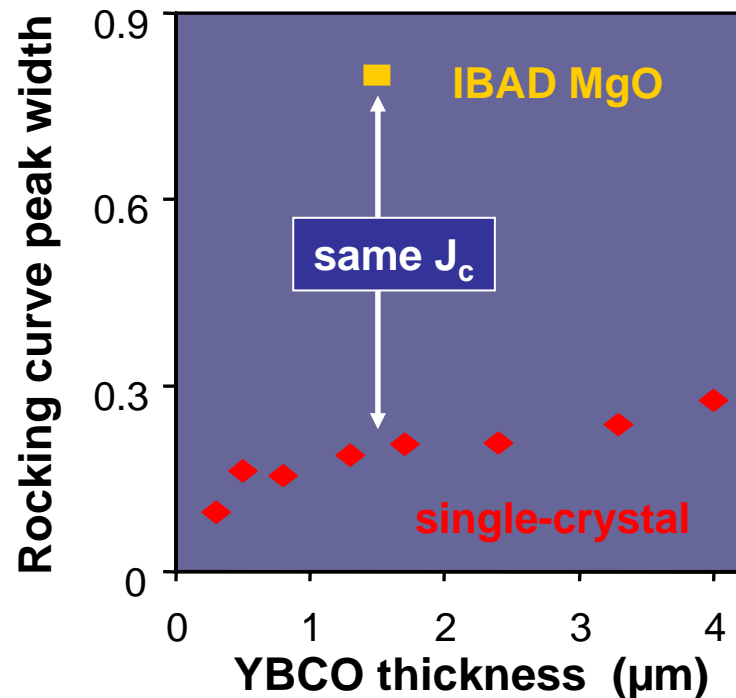
Q.X. Jia, *et al*, MRS Spring 2006

# Assessing the effect of microstructural decay is a difficult business...

- \* The observed decay of microstructure does not match the  $J_c$  trend for strong thickness dependence.



- \* Seemingly important changes in microstructure sometimes produce no change in  $J_c$ .



...but even if microstructural decay is not the main factor in strong thickness dependence, it can be a factor in all films

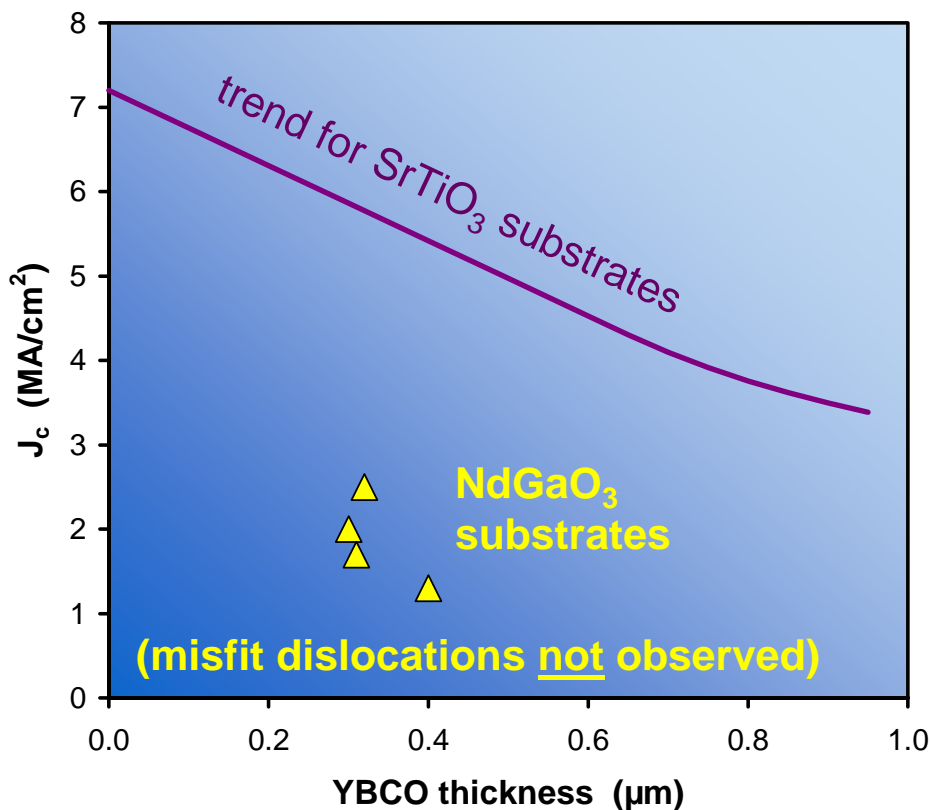
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- \* Because deterioration continues – or even accelerates – with increasing thickness, microstructural decay must become the dominant current-limiting aspect at some thickness .
- \* The thickness at which microstructural decay begins to limit  $J_c$  is likely dependent on deposition method and processing conditions.

# The interfacial enhancement model predicts that $J_c$ will decrease if we eliminate lattice mismatch

**Experiment :** Investigate the thickness dependence of YBCO on  $\text{NdGaO}_3$  substrates.

- ◆ (110)  $\text{NdGaO}_3$  has an excellent lattice match with YBCO.
- ◆ Such a small mismatch can be accommodated without formation of misfit dislocations.
- ◆ Will this affect  $J_c$ ?





## Low $J_c$ and the absence of observable misfit dislocations suggest the following scenario:

- \* The surface planes of both YBCO and (110)  $\text{NdGaO}_3$  have a rectangular lattice.
- \* YBCO: 0.382 nm x 0.388 nm     $\text{NdGaO}_3$ : 0.384 nm x 0.389 nm

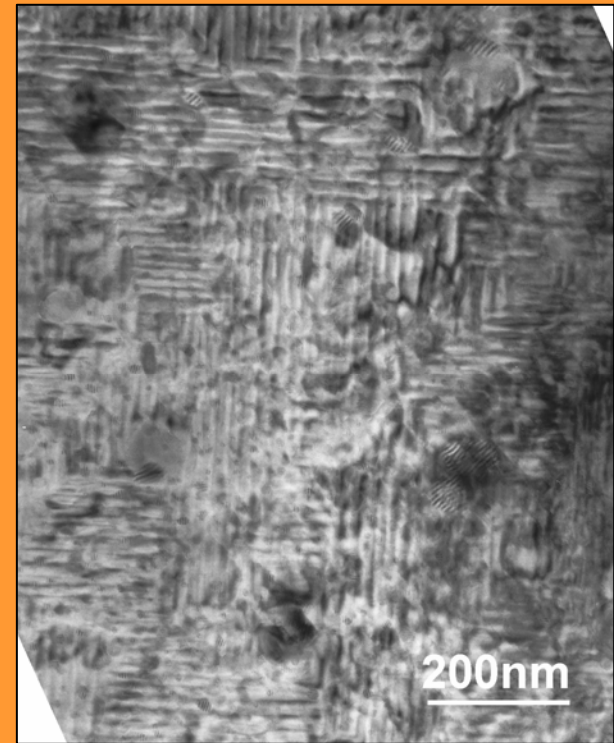
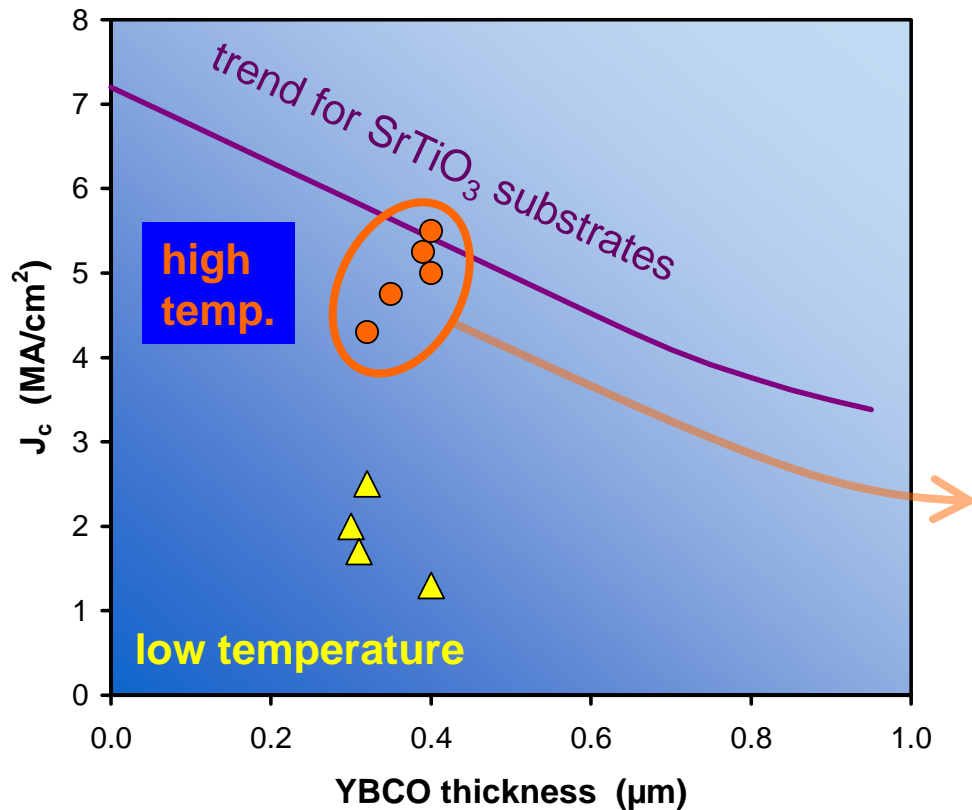


$$a_{\text{YBCO}} \parallel a_{\text{NdGaO}_3} (0.6\%)$$
$$b_{\text{YBCO}} \parallel b_{\text{NdGaO}_3} (0.15\%)$$

small mismatch  $\rightarrow$  few dislocations  $\rightarrow$   
no interfacial enhancement  $\rightarrow$  low  $J_c$

But – low  $J_c$  can be caused by a number of factors, including the possibility that the deposition temperature is not optimum.

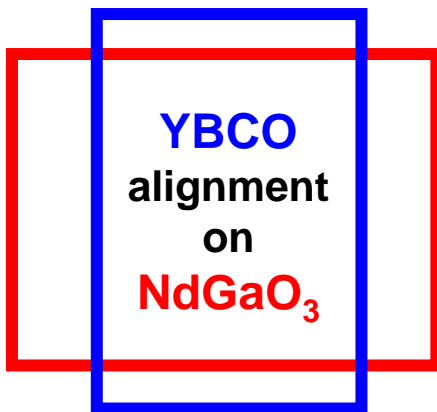
At higher deposition temperature,  $J_c$  improved and misfit dislocations were observed at the film-substrate interface



Moiré fringes indicate the presence of misfit dislocations in higher-temperature YBCO films on NdGaO<sub>3</sub>

# Increased $J_c$ and the presence of misfit dislocations at high temperature suggest the following scenario:

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$b_{\text{YBCO}} \parallel a_{\text{NdGaO}_3}$  (1.1%)  
 $a_{\text{YBCO}} \parallel b_{\text{NdGaO}_3}$  (1.8%)

larger mismatch  $\rightarrow$   
high dislocation density  $\rightarrow$   
interfacial enhancement  $\rightarrow$  higher  $J_c$

As unlikely as this epitaxial alignment may seem, there is good evidence that it is occurring in the high-temperature films  $\rightarrow$

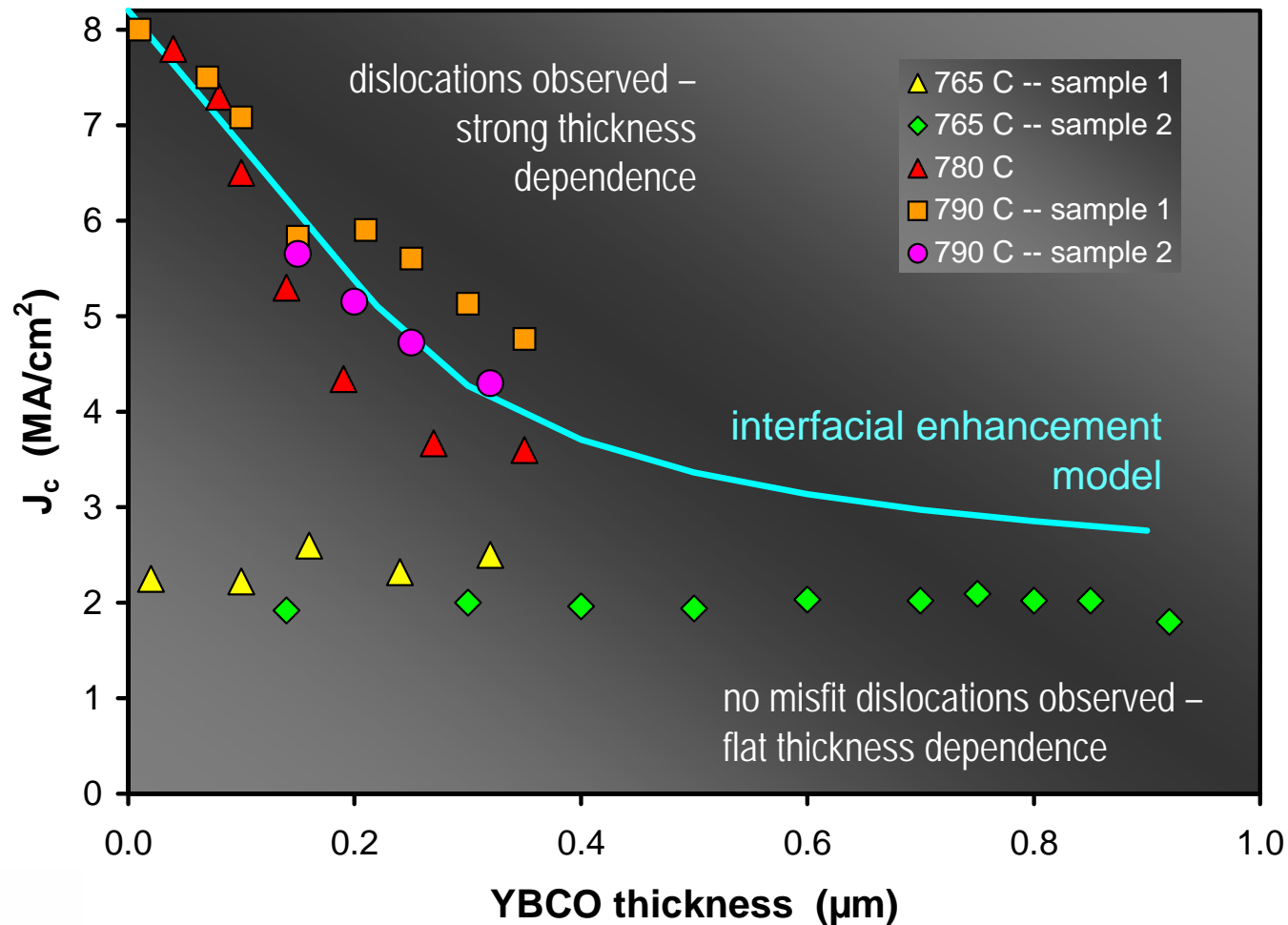
# The dislocation spacing is consistent with the rotated epitaxial relationship

- \* The predicted dislocation spacing for  $a_{\text{YBCO}} \parallel b_{\text{NdGaO}_3}$  is 20.6 nm:
- \* The observed moiré fringe spacing (same as the misfit dislocation spacing) is ~ 20 nm.
- \* The amount of mismatch (1.8 %) is comparable to the amount that produces closely-spaced dislocations in:
  - YBCO on  $\text{SrTiO}_3$  (2.4 %) or
  - YBCO on  $\text{CeO}_2$  (1.7 %).



Moiré fringes in a TEM plan view of a 20 nm-thick YBCO film on  $\text{NdGaO}_3$

The main point became clear when ion milled samples of each type showed a correlation between dislocations and  $J_c(t)$



# Two significant conclusions emerge from this result

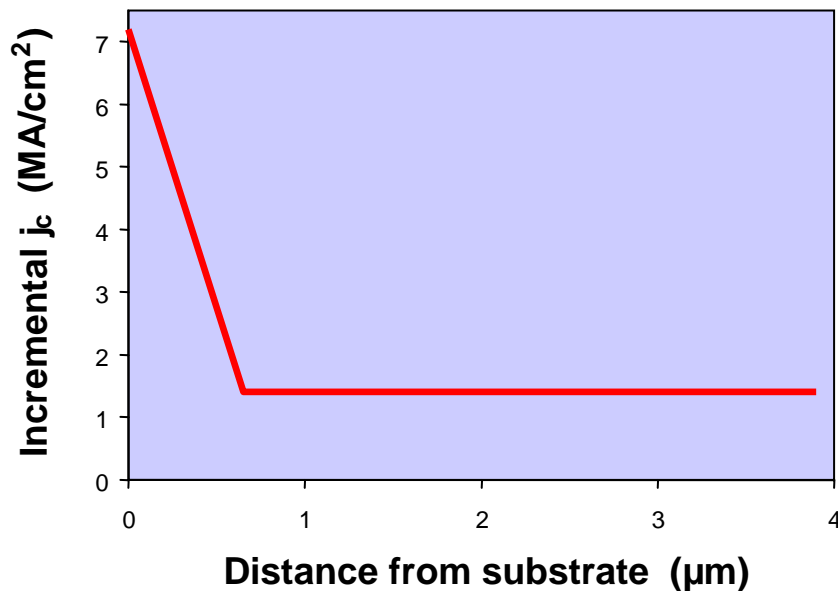
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1. There is a definite connection between misfit dislocations and strong thickness dependence.
  - \* However, dislocations may just be an indicator that interfacial enhancement is present, rather than the cause of interfacial enhancement.
2. It is possible to find processing conditions that eliminate thickness dependence.
  - \* This can explain reports in the literature of varying degrees of thickness dependence.
  - \* This ability will also be a valuable tool in determining the fundamental source of high interfacial  $J_c$ .

# In summary: There is much evidence in support of the interfacial enhancement model of thickness dependence

1. Incremental  $j_c$  is constant beyond a certain range and elevated only near the interface.

2. The interfacial region has a different microstructure, namely misfit dislocations.



# More evidence in support of the interfacial enhancement model of thickness dependence

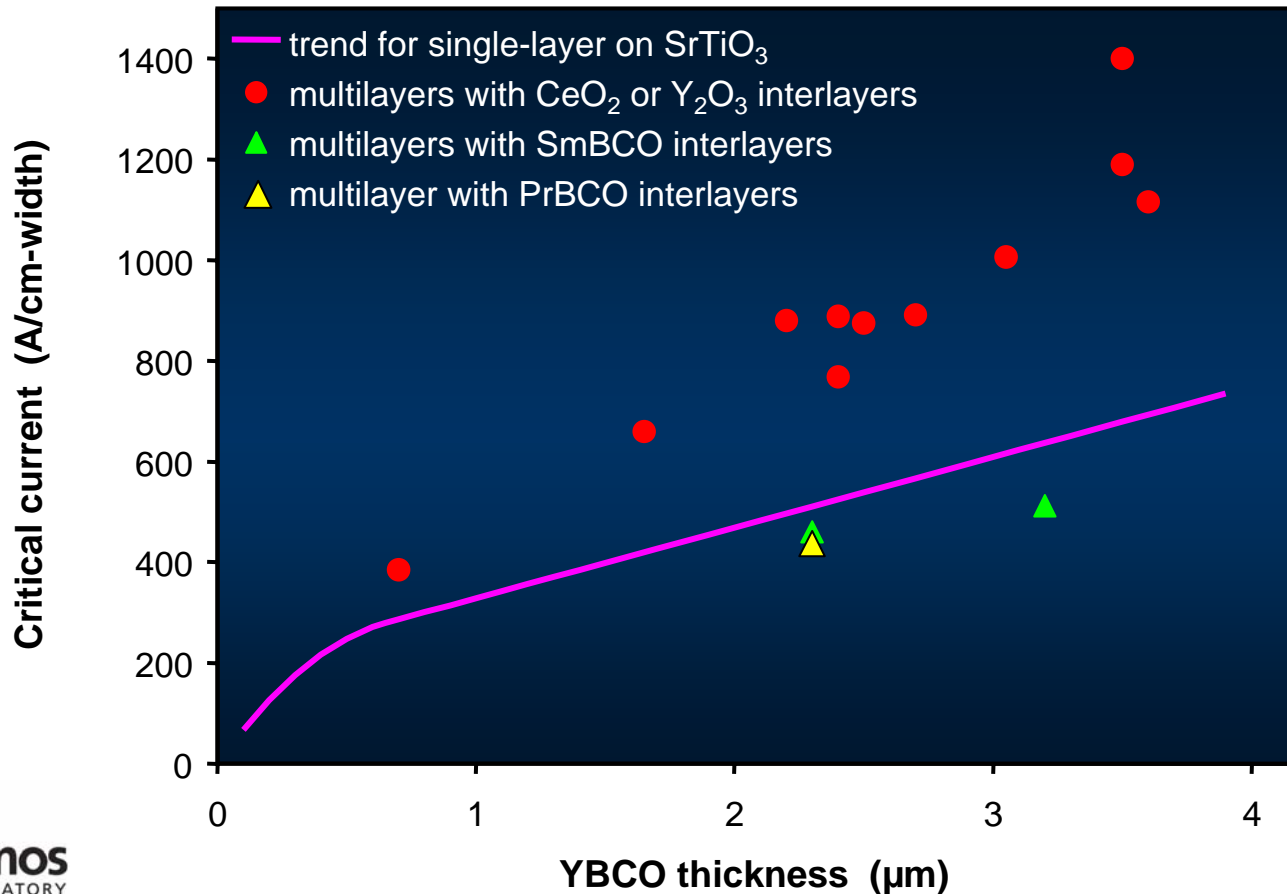
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3. Separating YBCO from the defect-rich interface with a PrBCO layer reduces  $J_c$ .
4. Inserting a  $\text{CeO}_2$  layer (and a new defect-rich interface) between YBCO and PrBCO restores  $J_c$ .
5. Films with misfit dislocations have high interfacial  $J_c$  and strong thickness dependence.
6. Films with no observable dislocations have flat thickness dependence and no enhancement of  $J_c$  near the interface.



# More evidence in support of the interfacial enhancement model of thickness dependence

7. Multilayers with heteroepitaxial interfaces “work” – those employing small mismatch have  $J_c$  similar to single layer YBCO.



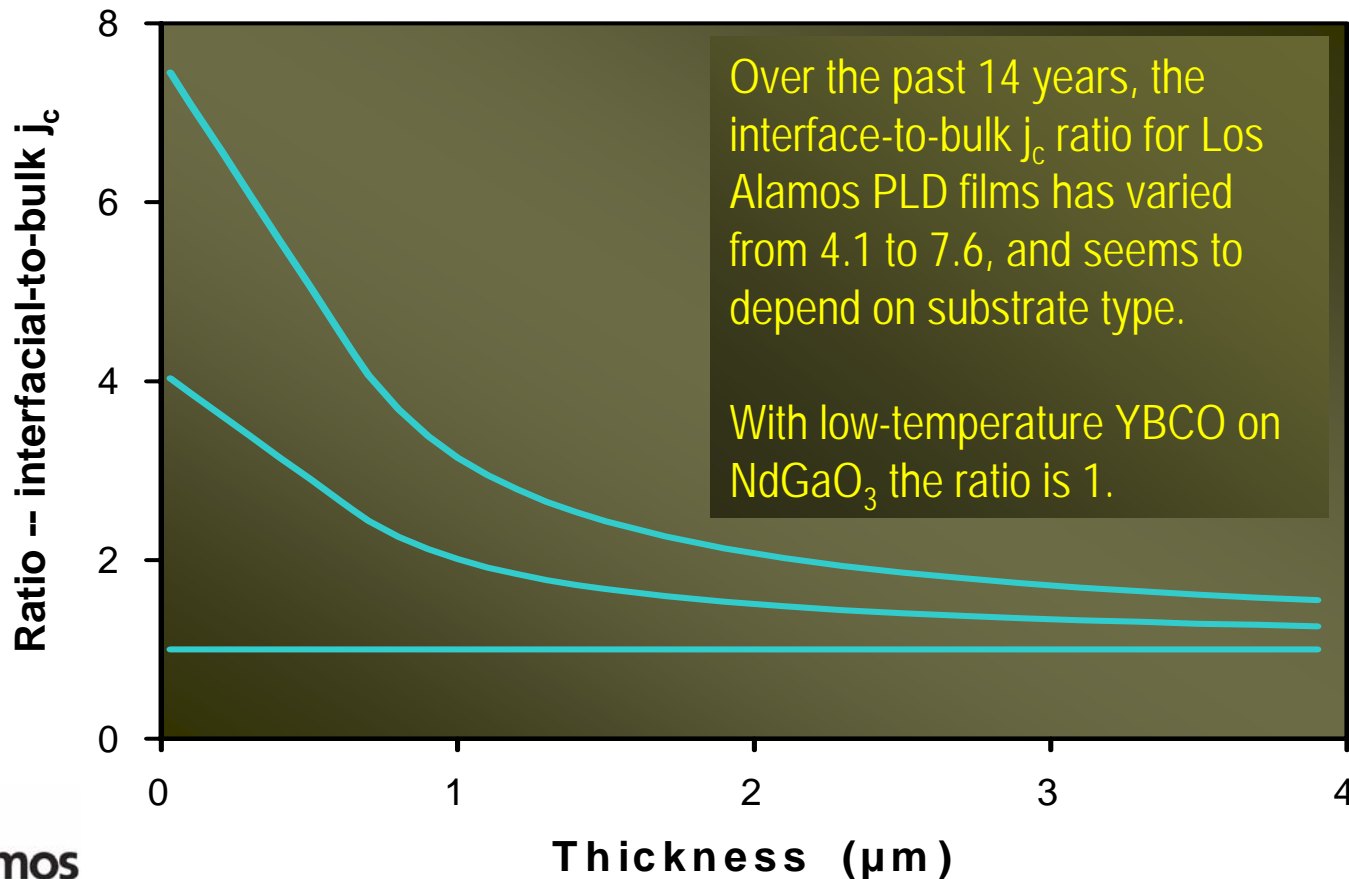
# The interfacial enhancement model can explain several other experimental observations

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1. Different YBCO deposition methods, each producing a unique microstructure, have strikingly similar thickness dependence.
  - \* All methods have two aspects in common: a small selection of suitable substrates and roughly the same deposition temperature.
  - \* These common aspects mean that interfacial stress – due to lattice misfit and differential expansion – is approximately the same for all deposition techniques.

# The interfacial enhancement model can explain several other experimental observations

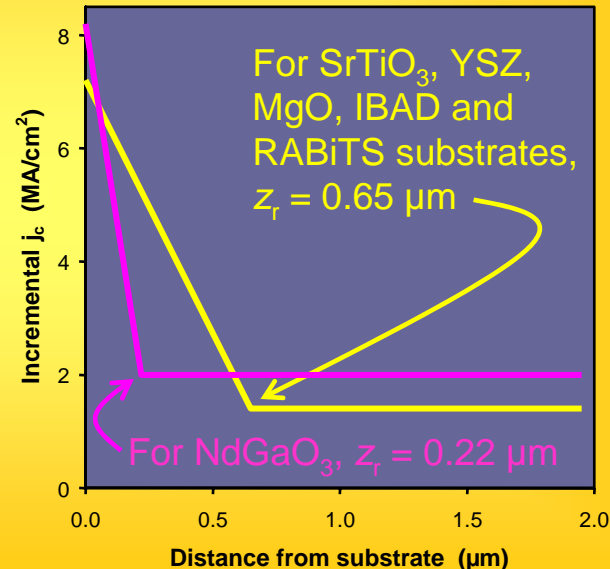
2. Different degrees of thickness dependence are reported – all can be readily modeled by varying the relative strength of interfacial pinning.



# Because of strong evidence for interfacial enhancement our work will now focus on identifying its source

Interfacial enhancement implies a higher degree of beneficial properties near the film-substrate interface. There are several clues that may help identify the desirable properties:

1. A confirmed link between misfit dislocations and thickness dependence.
2. The range of interfacial enhancement is shorter on NdGaO<sub>3</sub> substrates than on others.



## More clues that may help identify desirable interfacial properties

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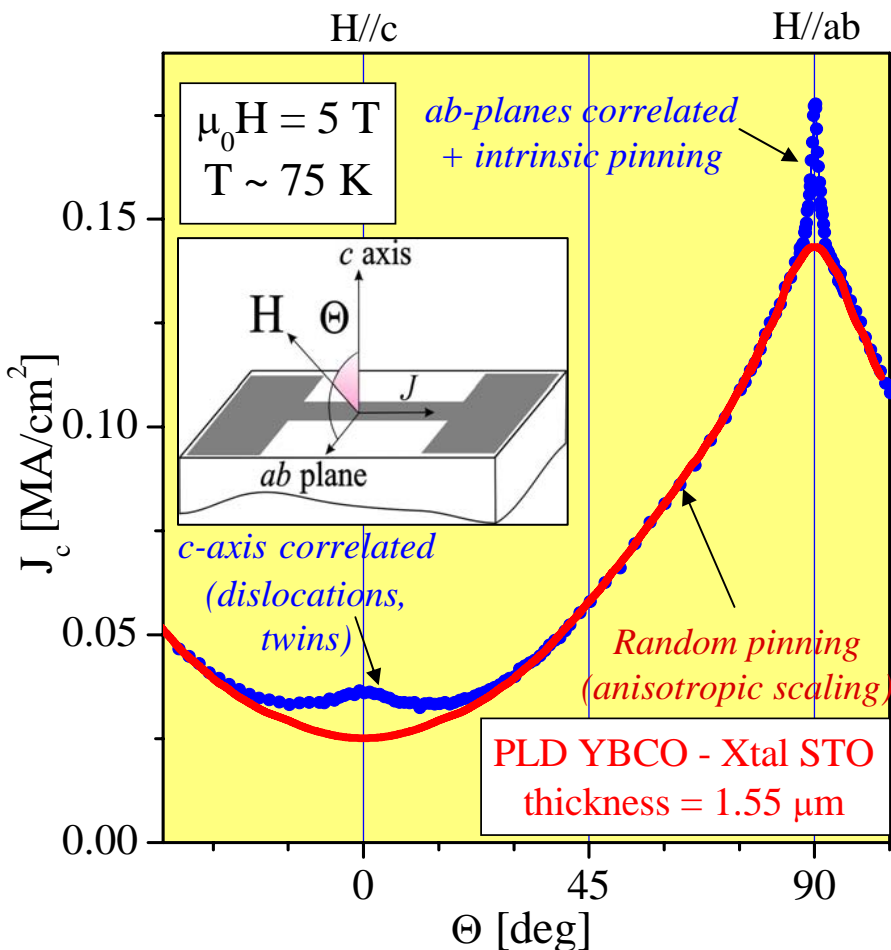
3. Higher cation disorder is observed closer to the interface (V. Maroni, this Review).
4. Smaller c-axis lattice constant is observed closer to the interface (B. Gibbons, *et al.*, MRS, Spring 2006).
5. Etching reveals higher dislocation density closer to the interface (K. Develos-Bagarinao, *et al.*, Supercond. Sci. Technol. **18**, 667 (2005)).

# The concept that defects influence the interfacial properties of electronic thin films is widely reported

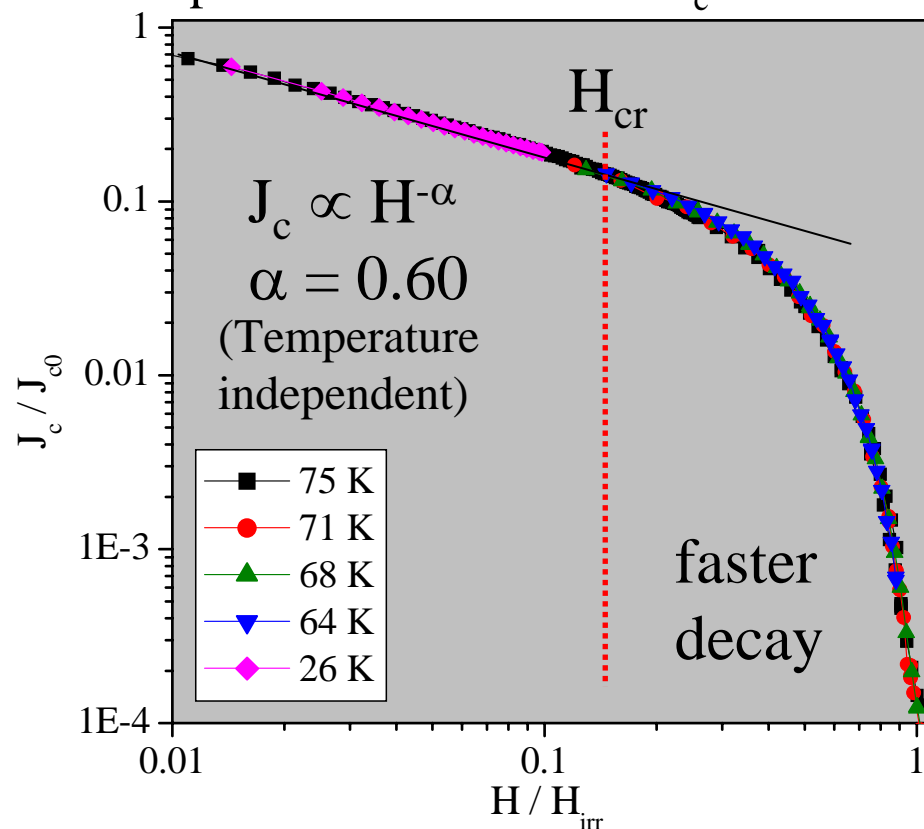
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- \* The first detailed study took place more than thirty years ago to investigate possible adverse effects on the performance of superlattice devices. ("Defects in epitaxial multilayers, Part 1. Misfit dislocations", J.W. Matthews and A.E. Blakeslee, J. Crystal Growth **27**, 118 (1974).)
- \* There is now a large body of literature reporting interfacial effects on properties of a wide range of electronic film materials.
- \* The main difference in the case of HTS films is that the interfacial properties are enhanced, not degraded, by defects. But the fact that defects are responsible for improving  $J_c$  of YBCO films (e.g., relative to single-crystals) is well-established.

# We use the field, angular and temperature dependences of $J_c$ to identify pinning mechanisms and regimes

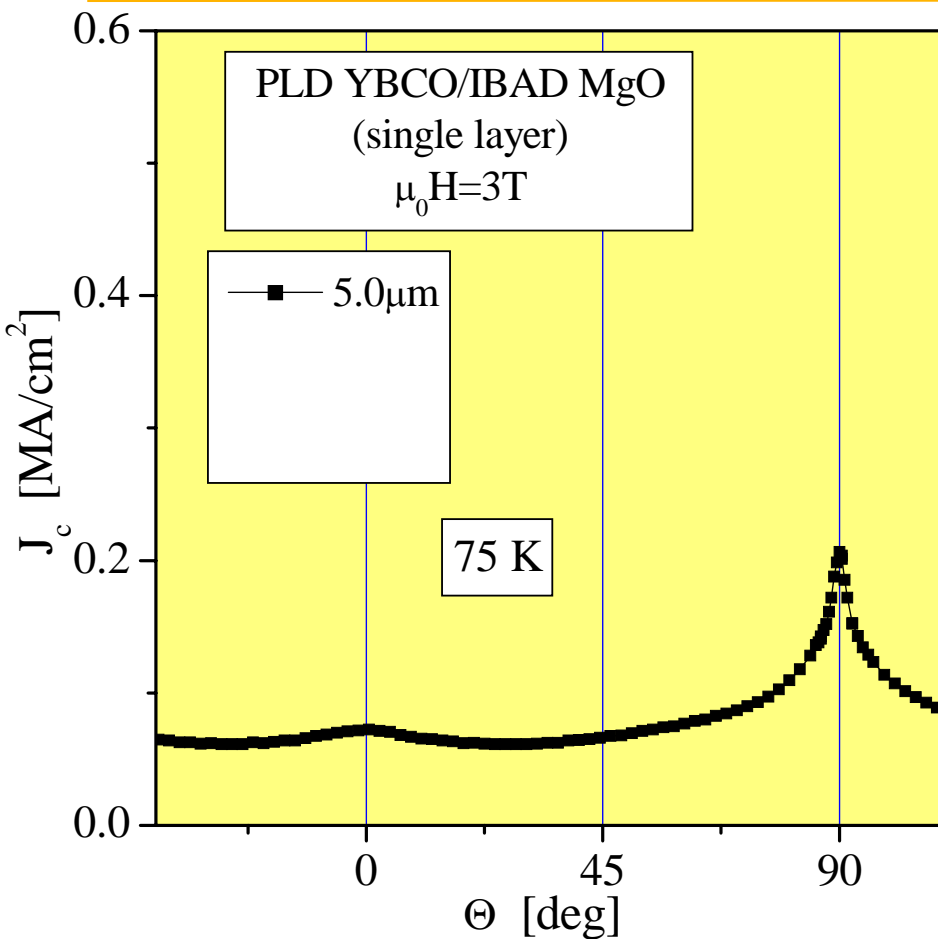


Of particular relevance is  $J_c$  for  $H//c$ :

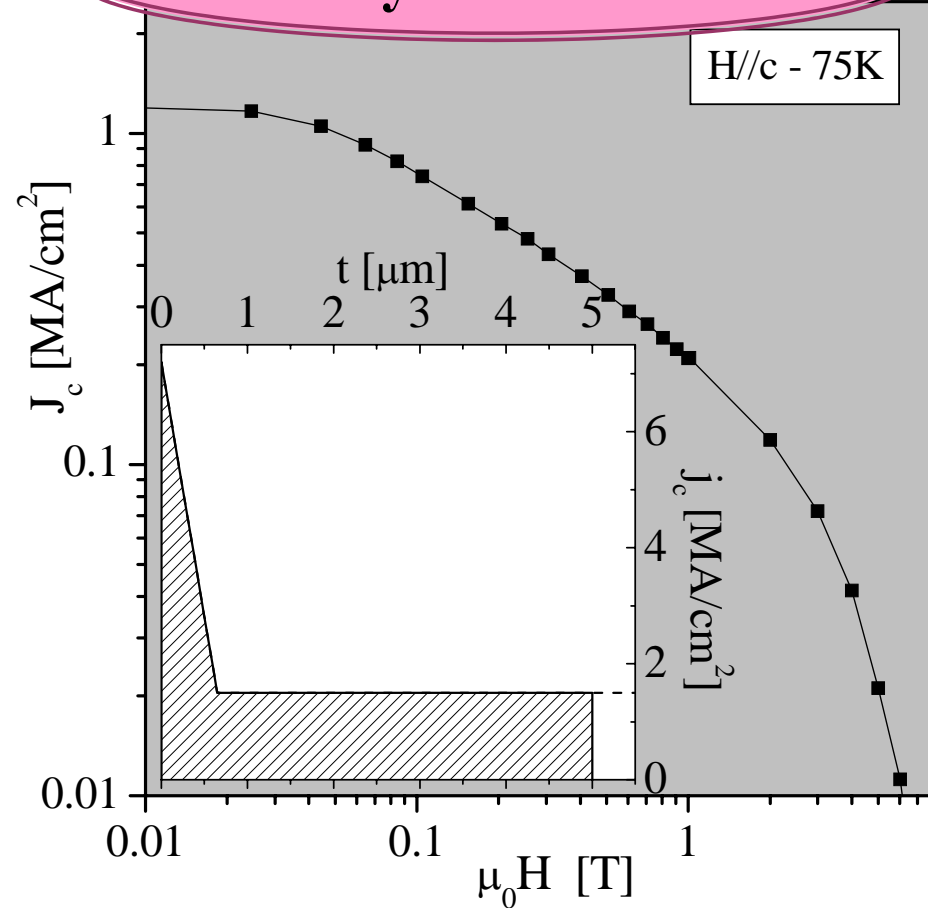


Last year we started to apply these tools to investigate the thickness dependence

# Ion milling of a thick PLD film: from $t = 5\mu\text{m}$ to $t \sim 0.7\mu\text{m}$ the shape of $J_c(T, H, \Theta)$ remains almost the same

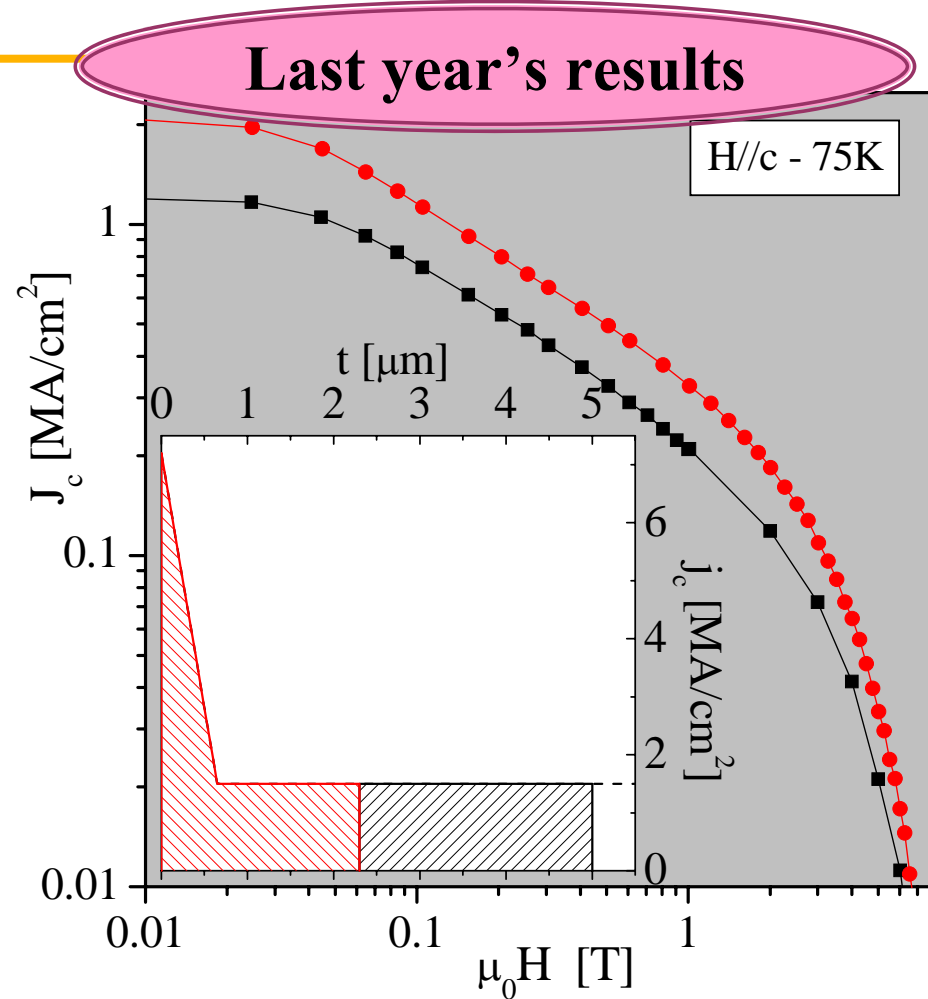
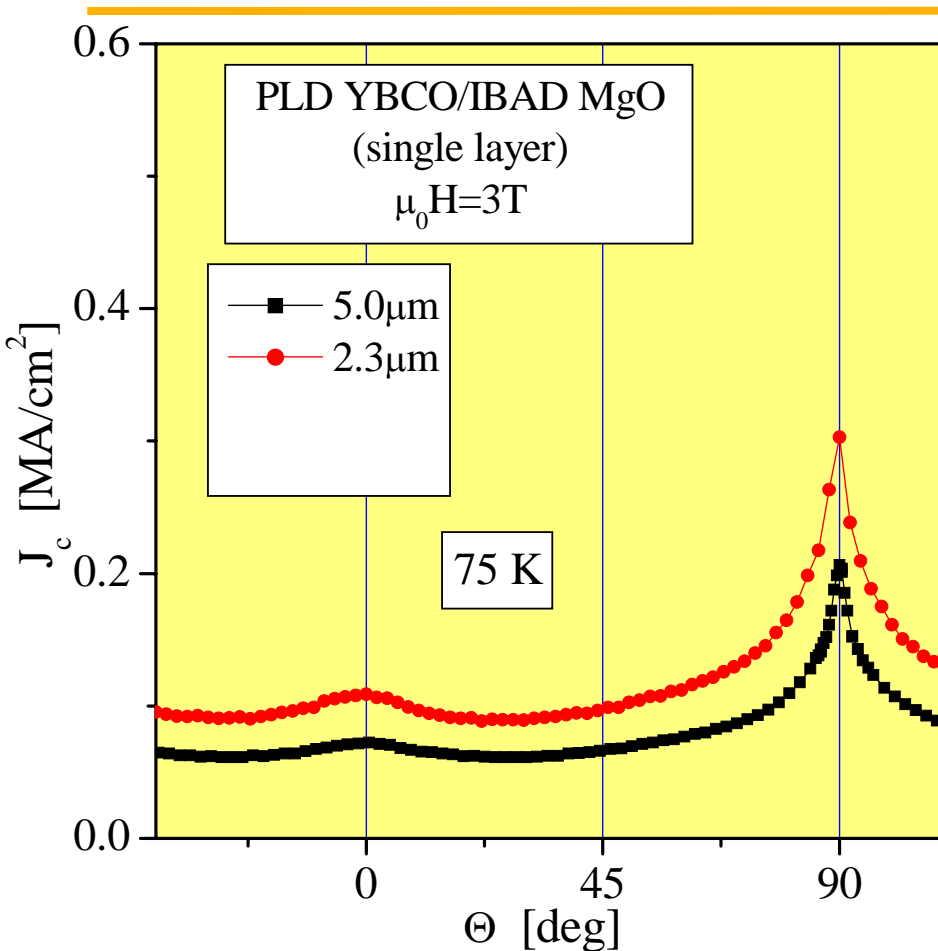


## Last year's results

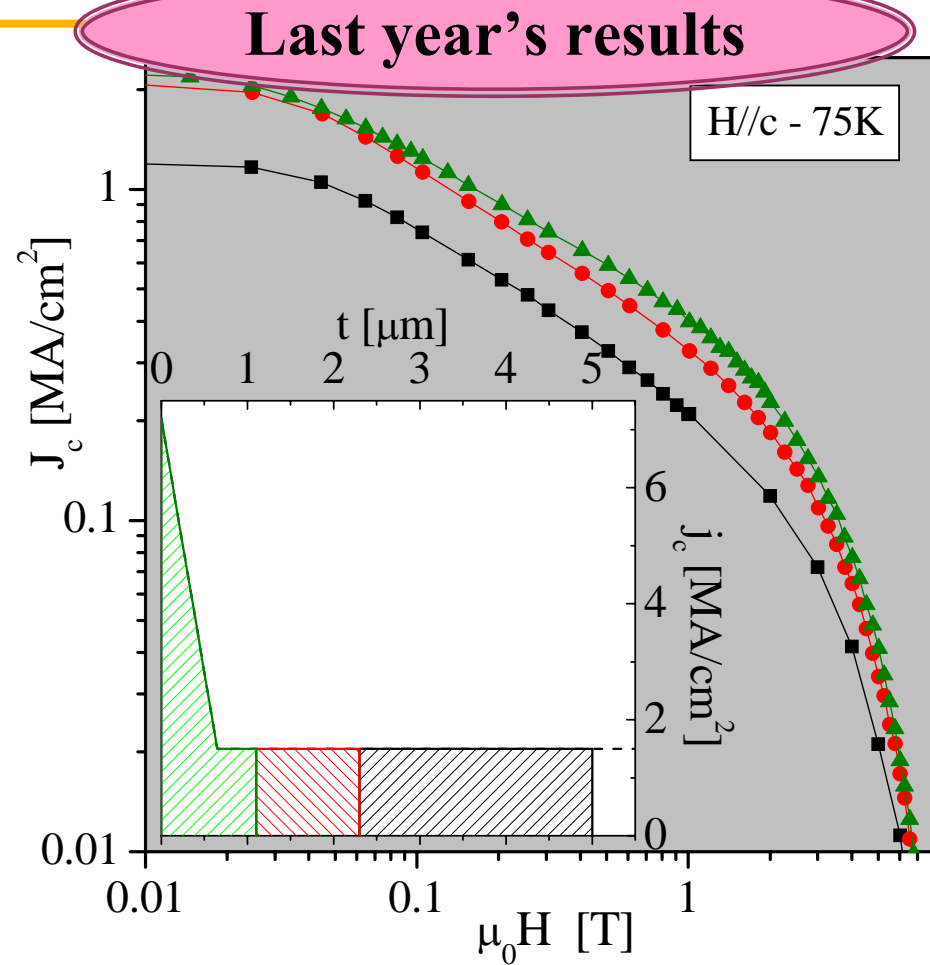
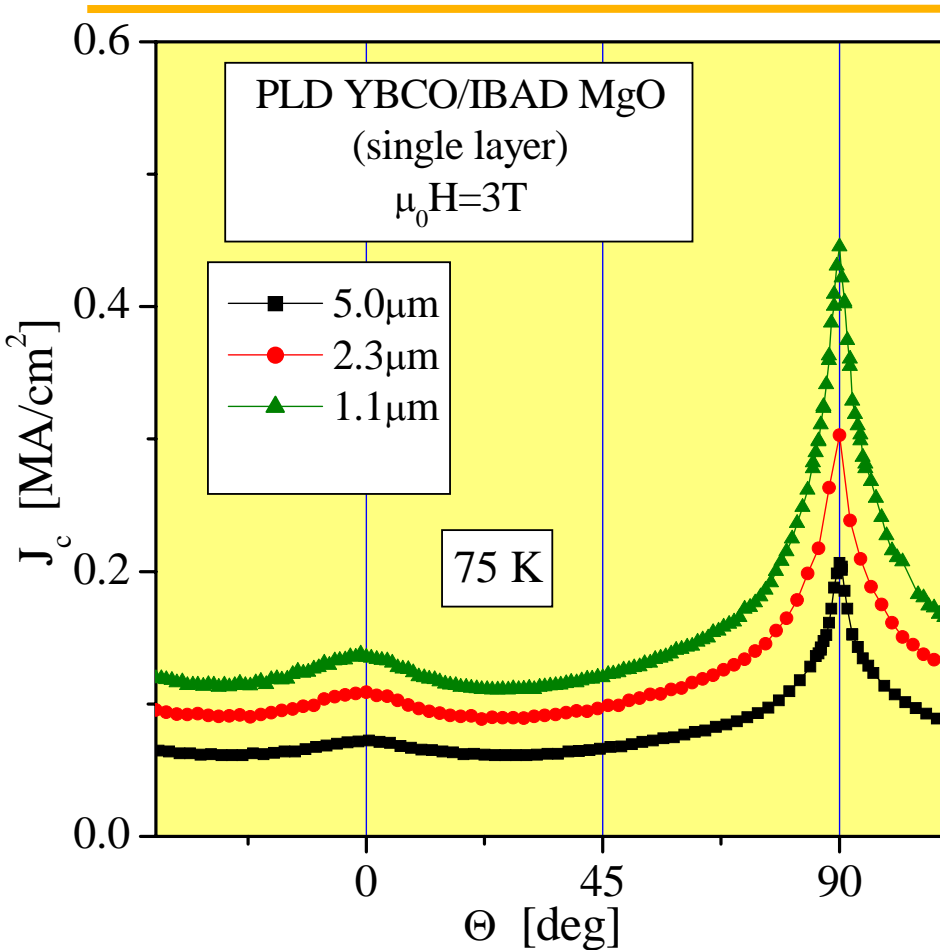




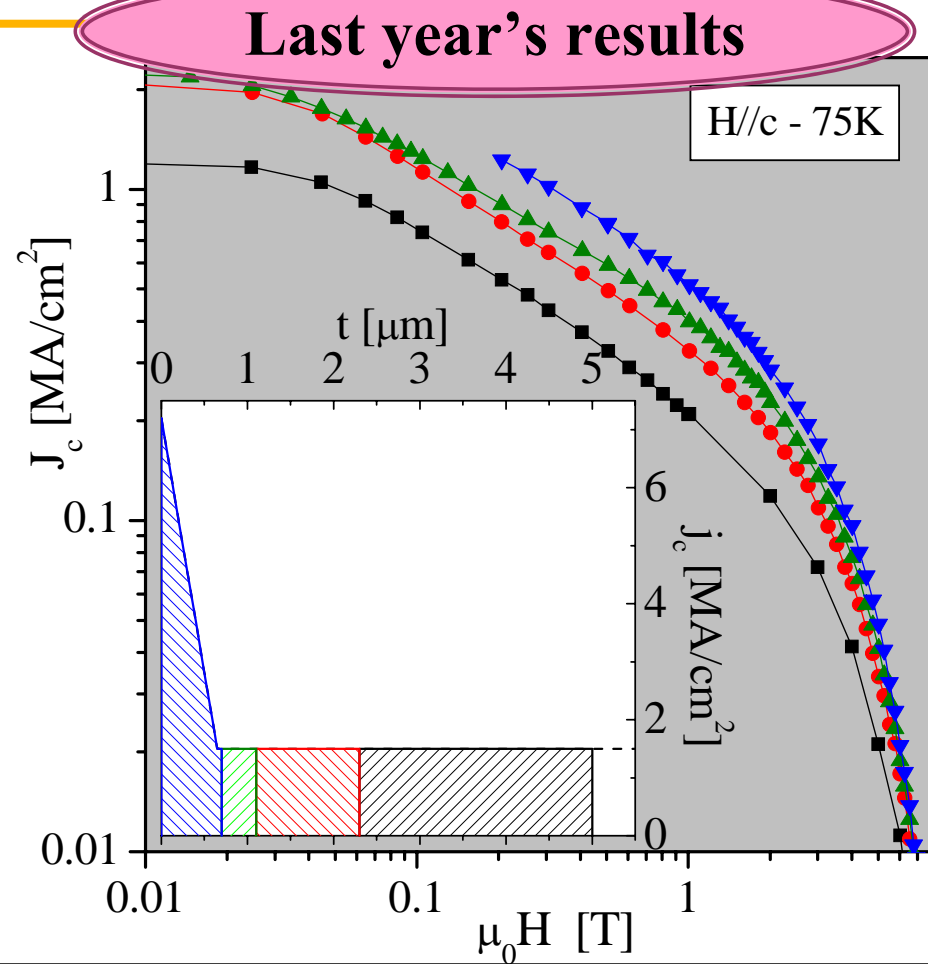
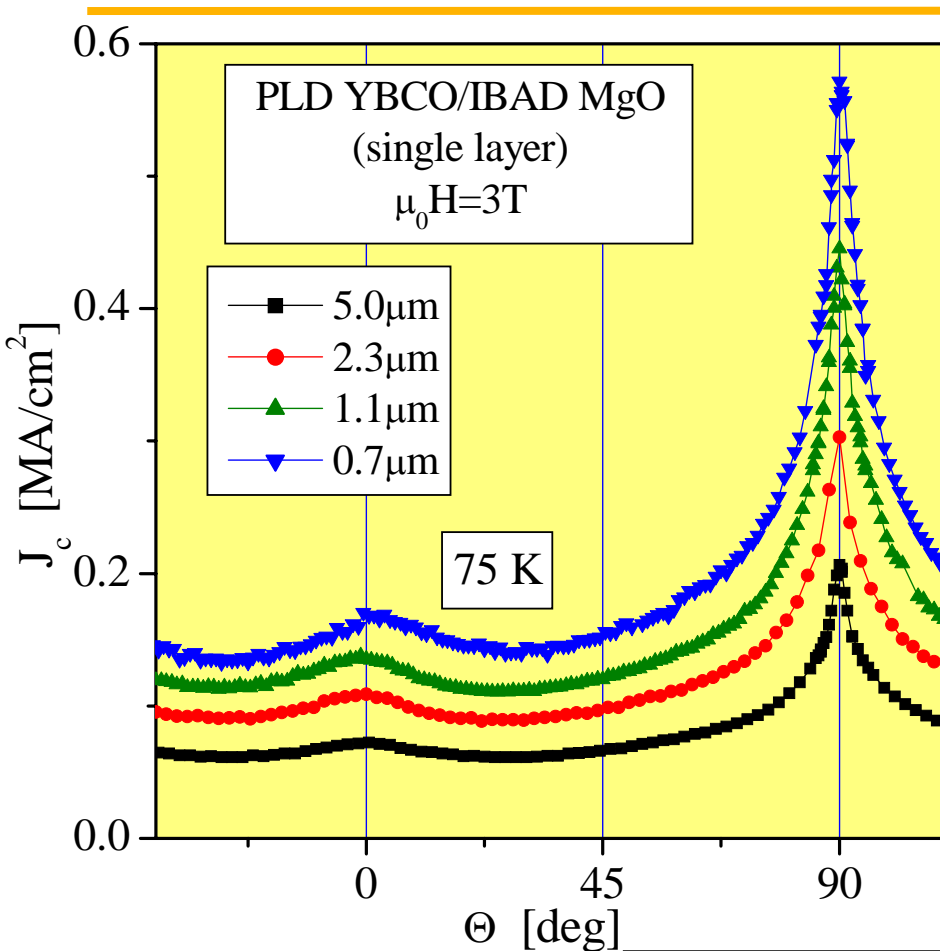
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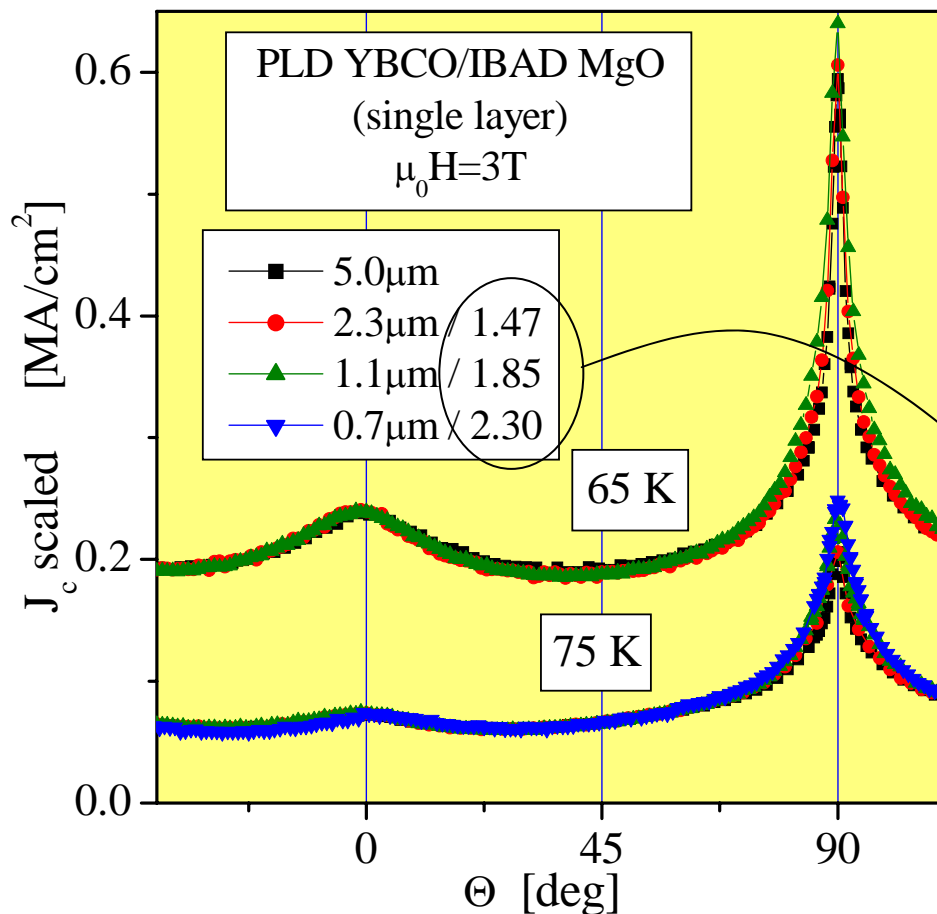


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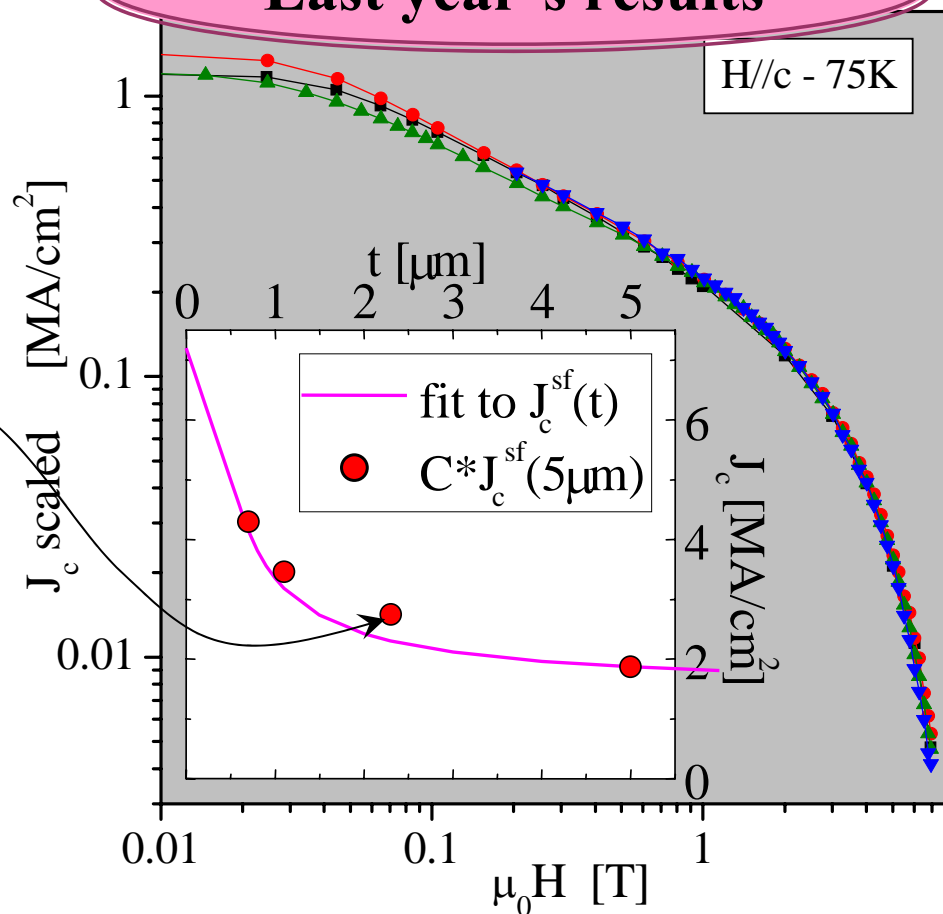


$J_c(T, H, \Theta)$  changes orders of magnitude, but *to first approximation*  $J_c(T, H, \Theta)_t \sim C * J_c(T, H, \Theta)_{5\mu\text{m}}$

Curves for all thicknesses can be overlapped by just dividing by a factor, which is the same one obtained for self field

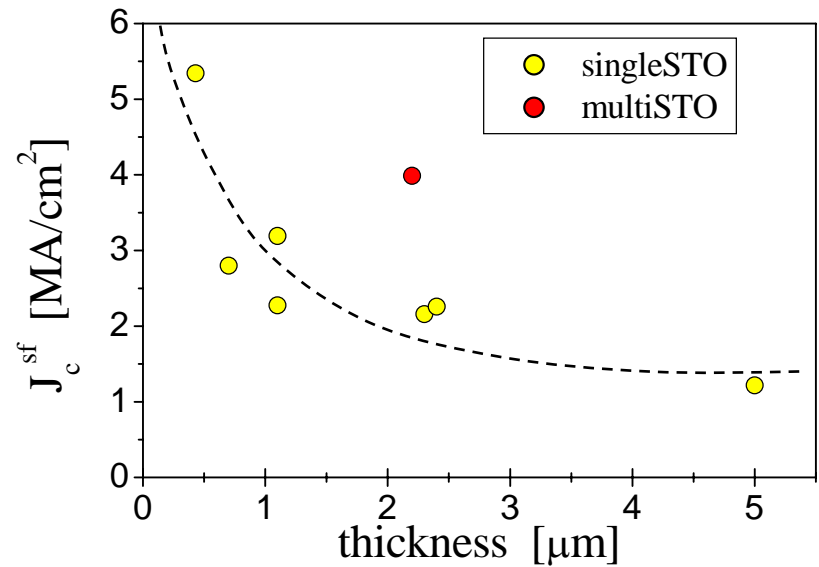
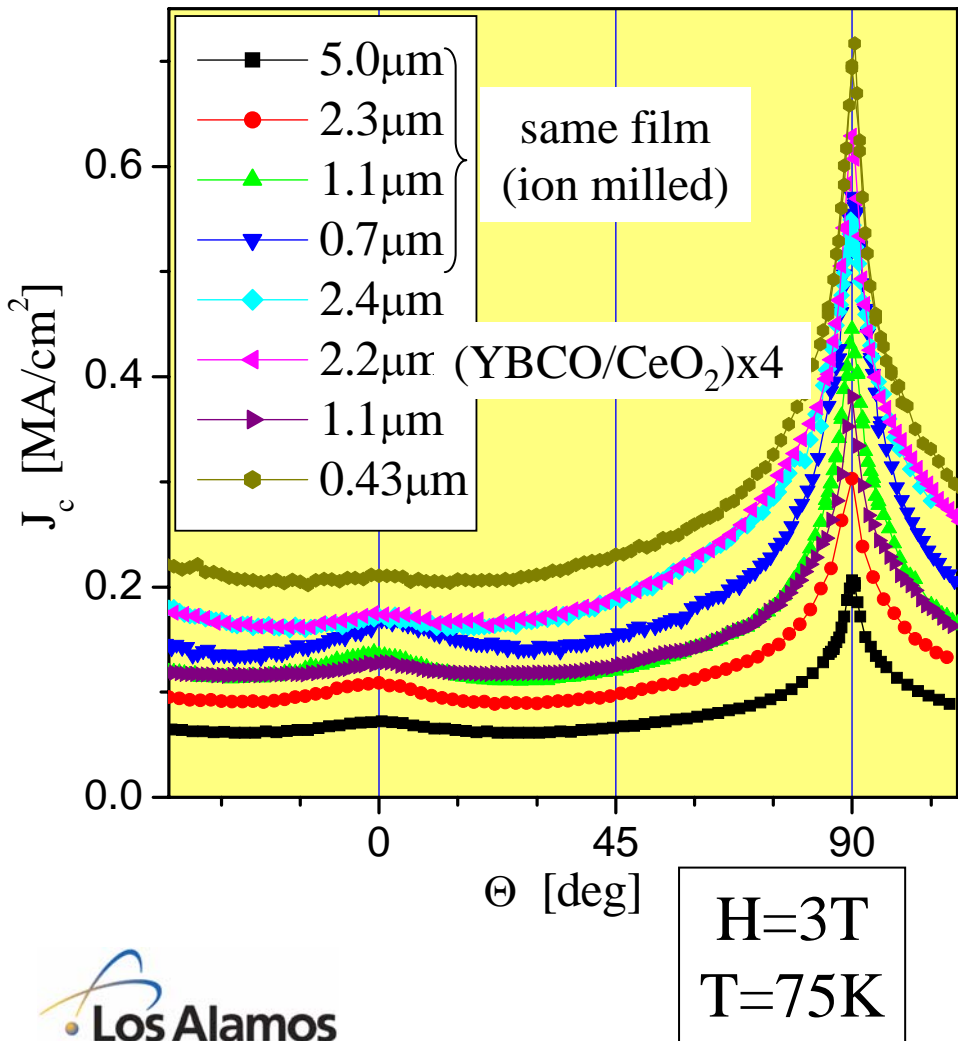


## Last year's results



- We will now perform a comparative study on many samples
- First question: How universal is this  $J_c(H, \Theta)$  dependence?

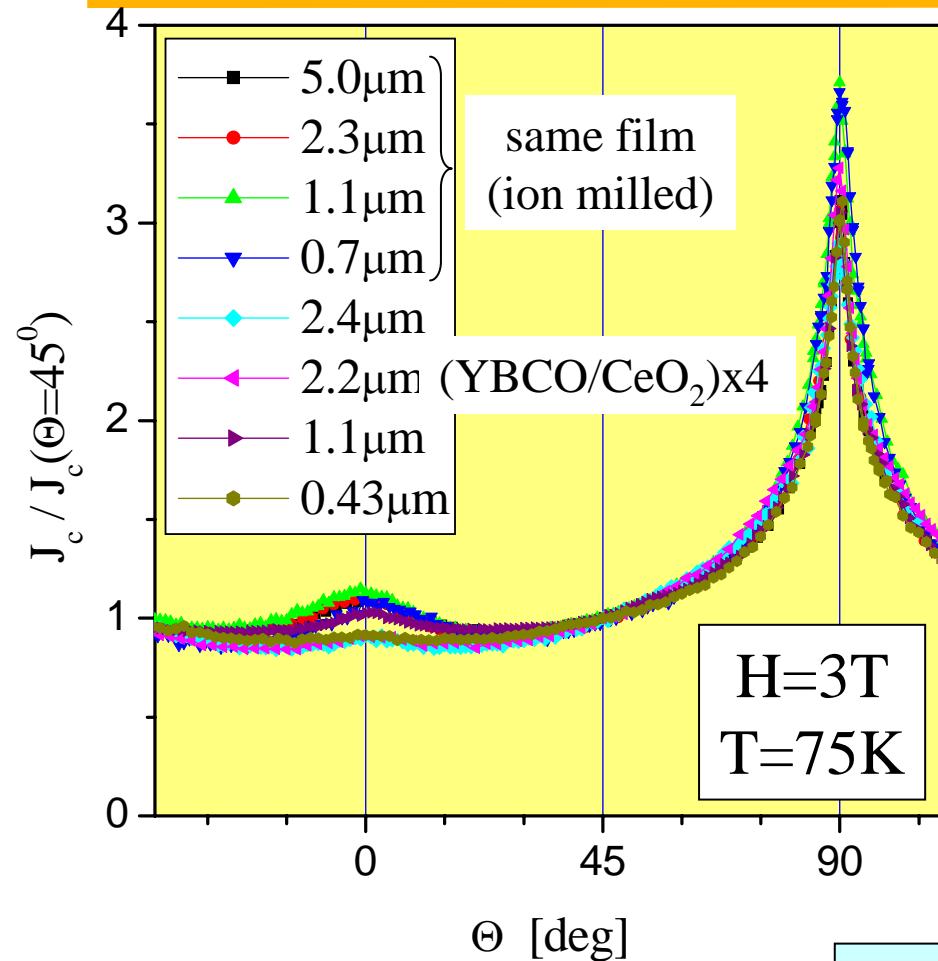
# The *shape* of $J_c(\Theta)$ is similar for a wide range of PLD YBCO films on STO



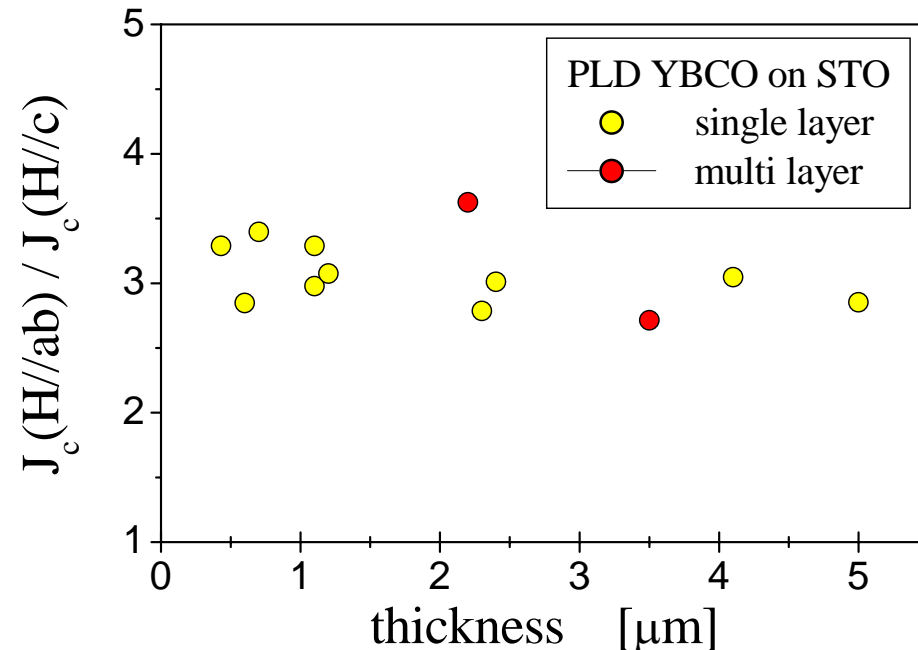
Includes:

- Films on STO single xtal substrates and on STO buffers on single xtal or IBAD MgO
- Single and multilayers
- More than one order of magnitude variation in thickness
- Factor of 4 variation in  $J_c(sf)$
- *Other films (not shown) have similar shape*

Normalized  $J_c(\Theta)$  curves almost overlap: Similar anisotropic random pinning. Some variations in peaks for H//c and H//ab

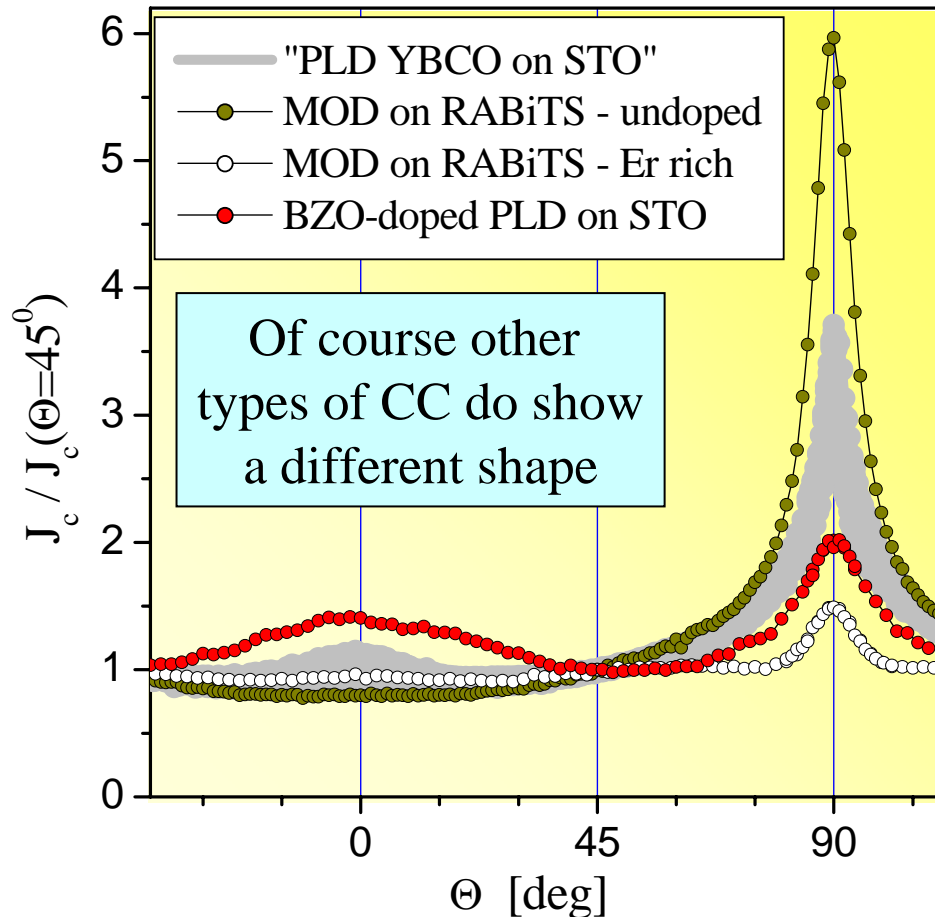
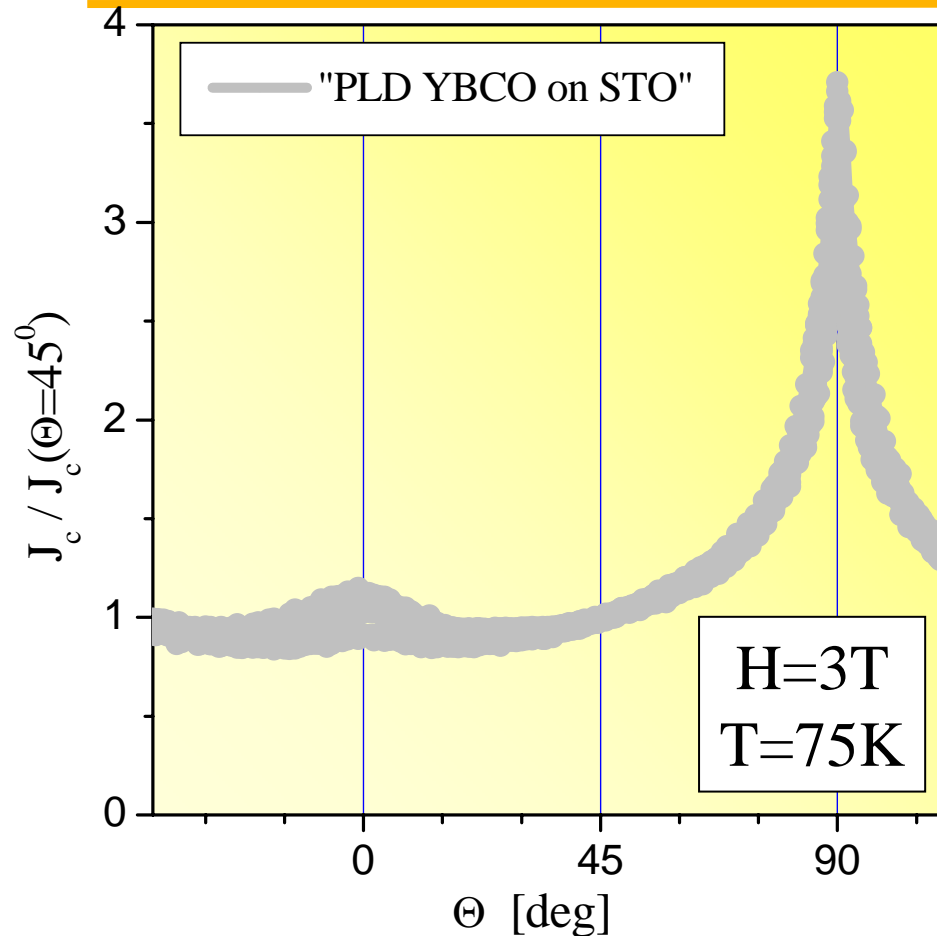


$J_c(\Theta)$  curves normalized at  $\Theta=45^\circ$   
arbitrary but useful to see overall trend



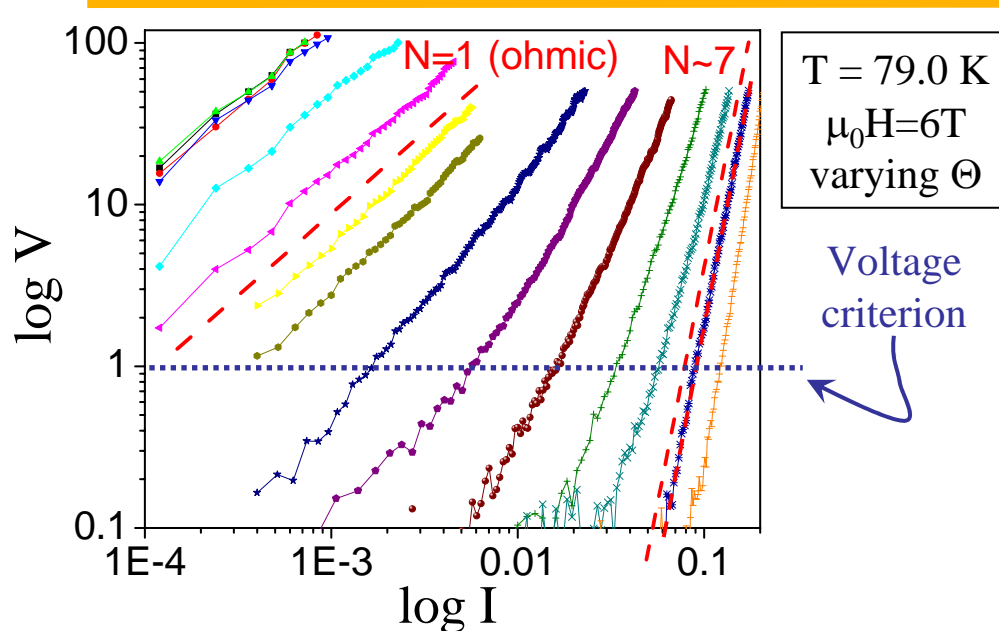
Similar  $J_c(H//ab)/J_c(H//c)$  ratio in all cases ( $\sim 3$ )

We can build a fuzzy “normalized  $J_c(\Theta)$  curve” for PLD YBCO on STO, to be used for later comparisons



# I-V curves are well described by a power law $V \propto I^N$

## What can we learn from $N(T, H, \Theta)$ ?

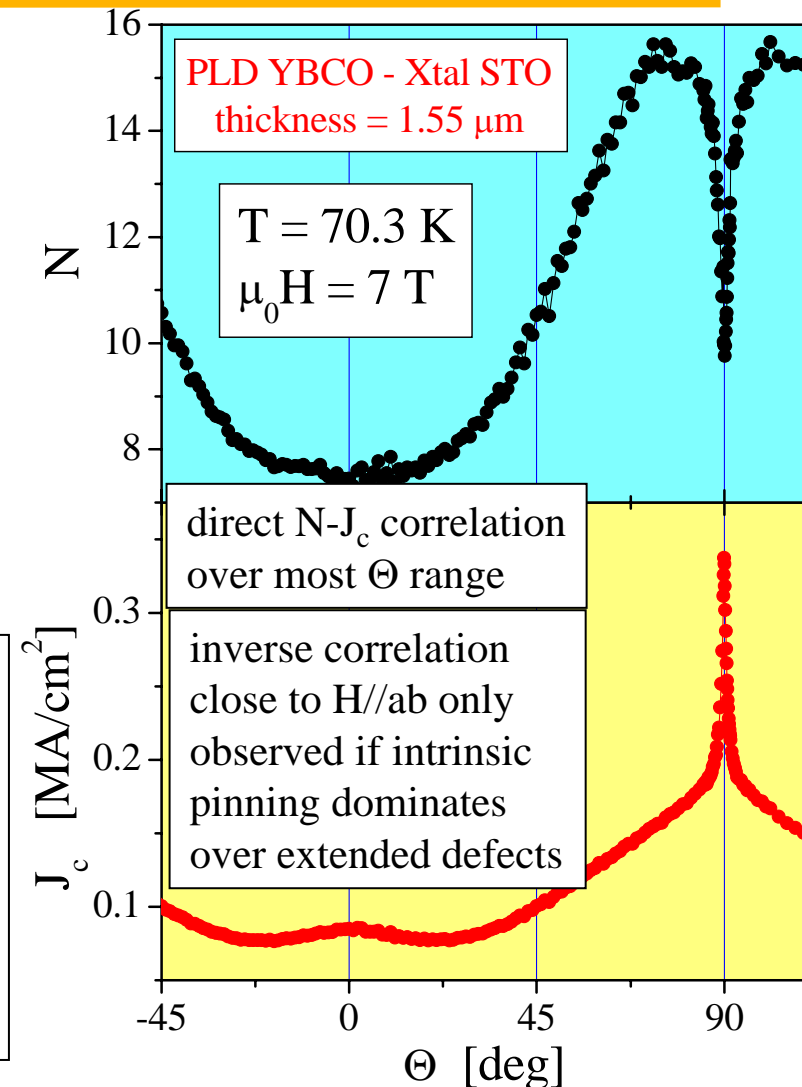


N value determined by flux creep (in contrast to LTS)

$$\begin{matrix} N \sim U_p / kT \\ J_c \propto U_p \end{matrix} \Rightarrow N \text{ should increase with increasing } J_c$$

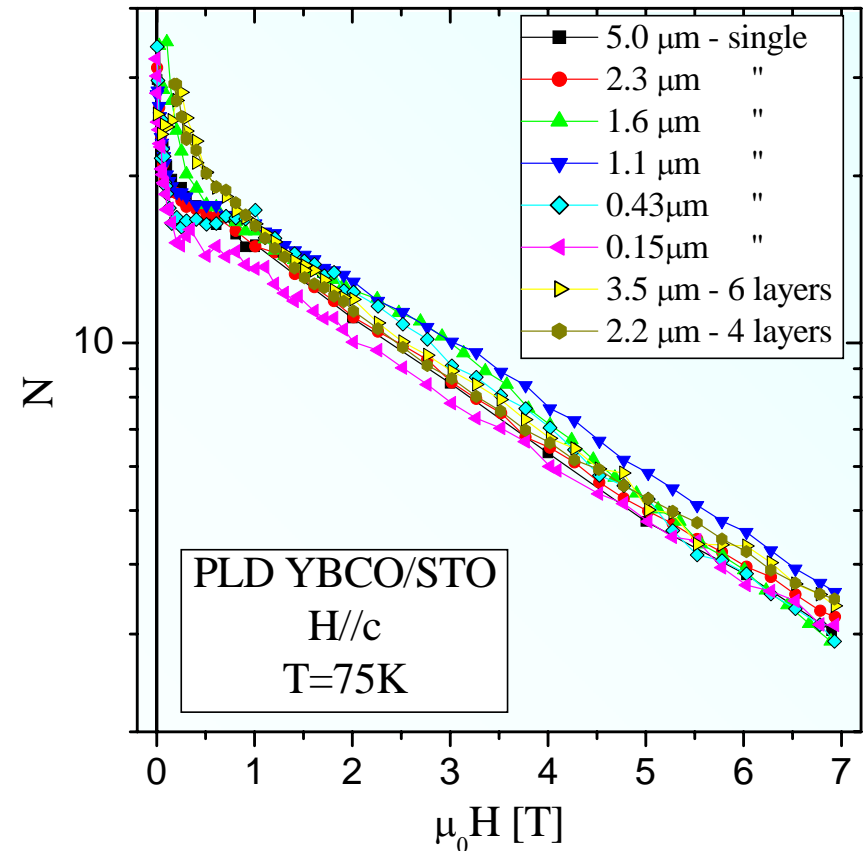
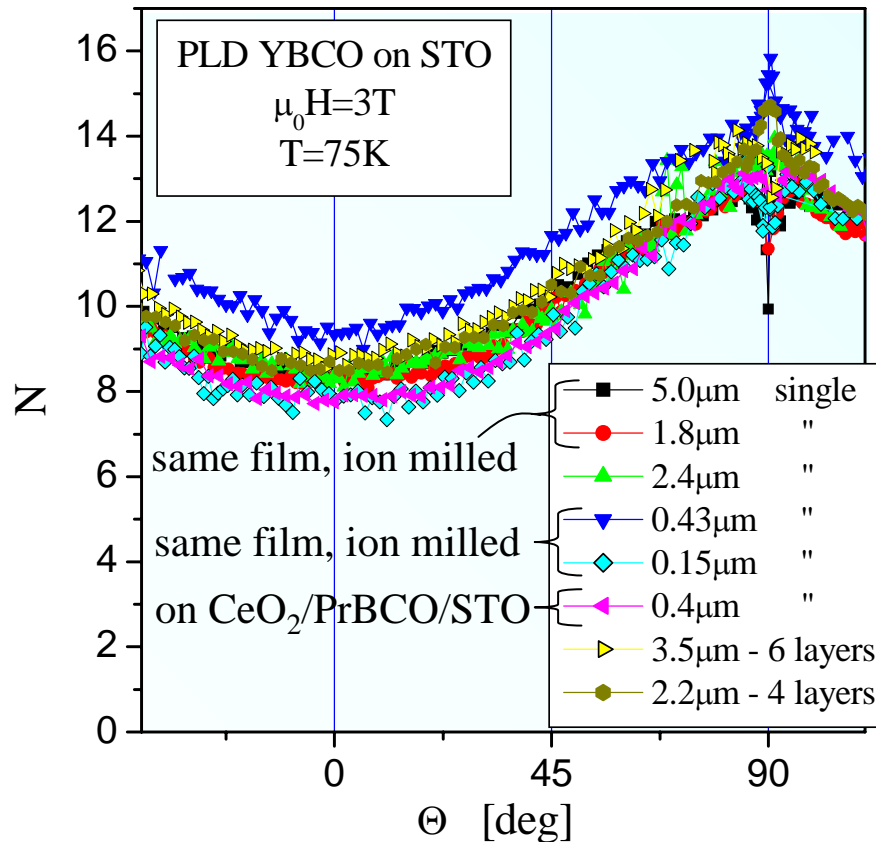
**Fact:** Usually this is true, as a function of:

- sample - H - T
- What about  $N(\Theta)$  ?





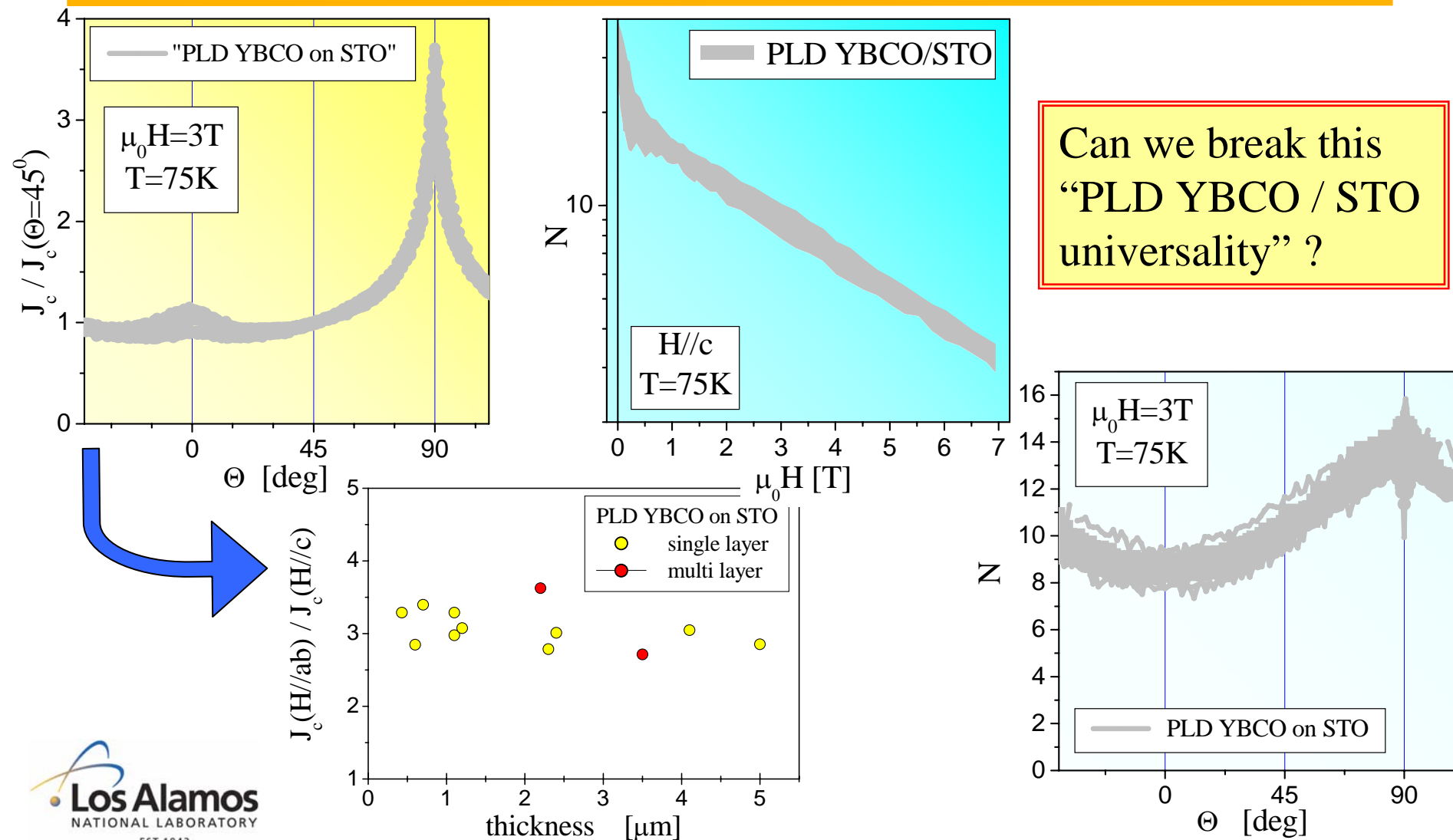
# The $N(H, \Theta)$ values are almost the same for all samples: Similar activation energy $U_p(H, \Theta)$ in all cases



The largest variability is observed:

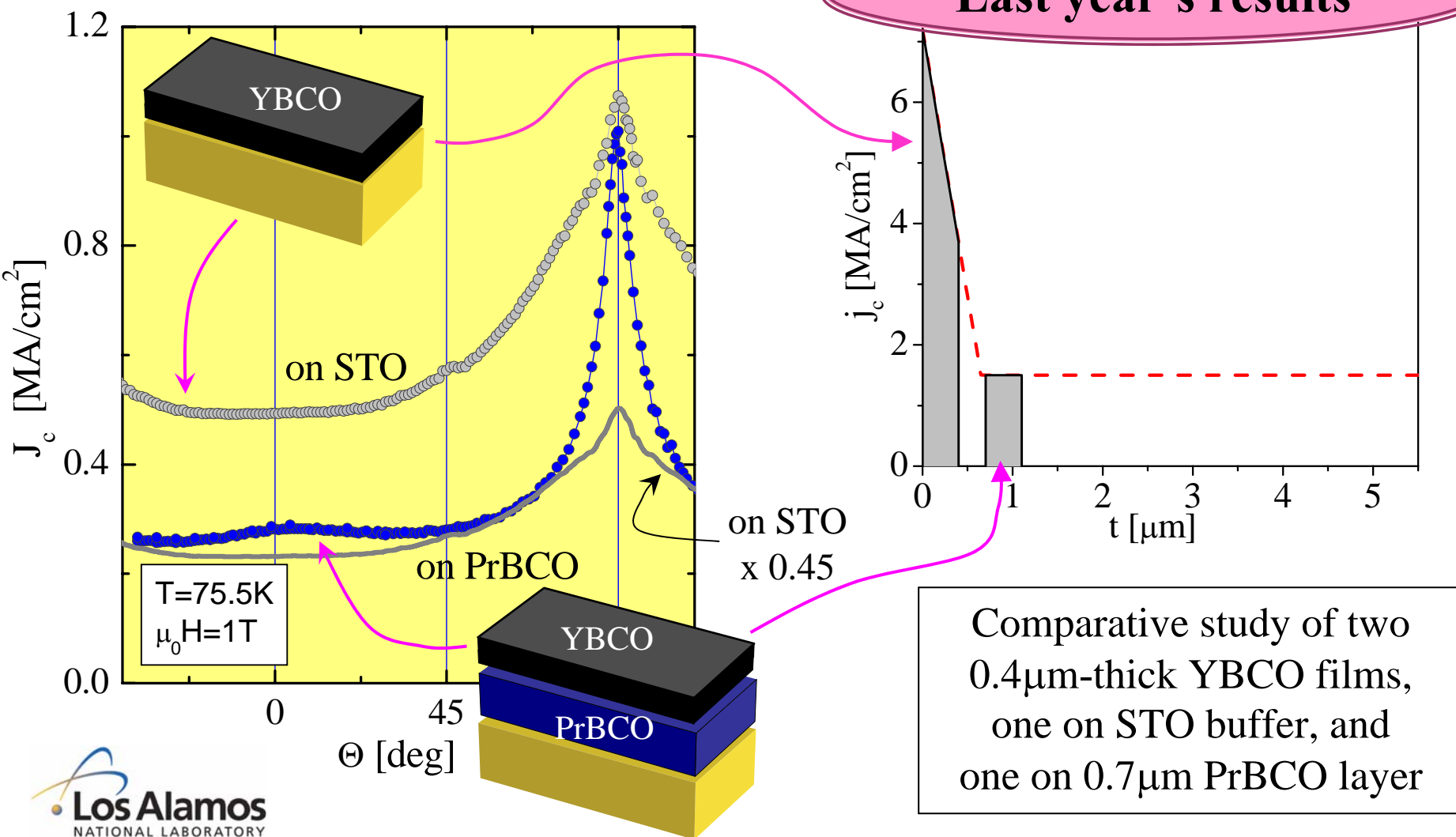
- At low fields
- Near  $H//ab$  (intrinsic pinning vs extended defects, shown in PR05)

# Summary: evidence indicates that the dominant pinning mechanisms are the same for all PLD YBCO/STO films (thickness from 0.15 to 5 mm, single- and multi-layers)

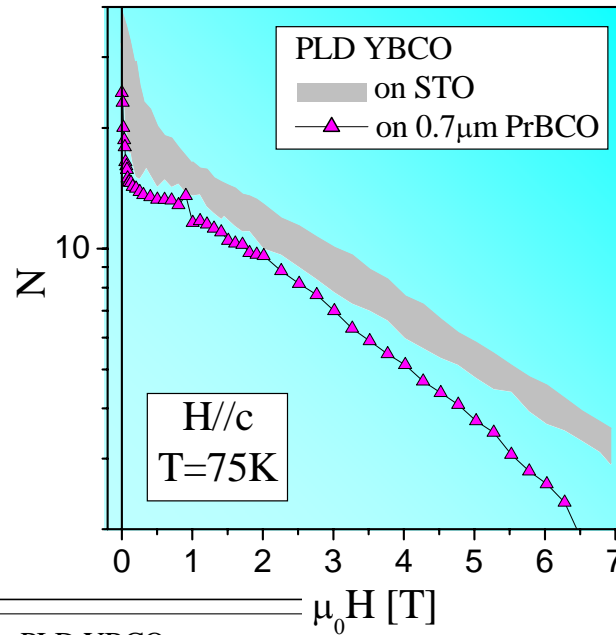
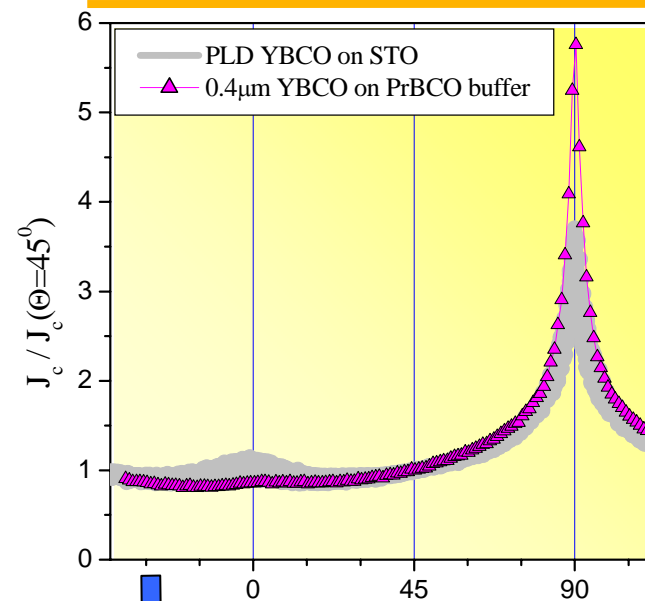


# A PrBCO spacer layer separating the YBCO from the STO interface eliminates the $J_c$ enhancement

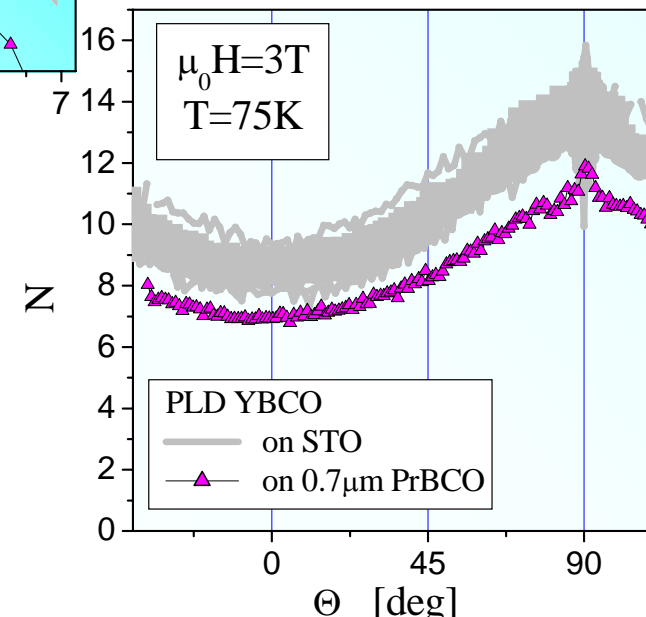
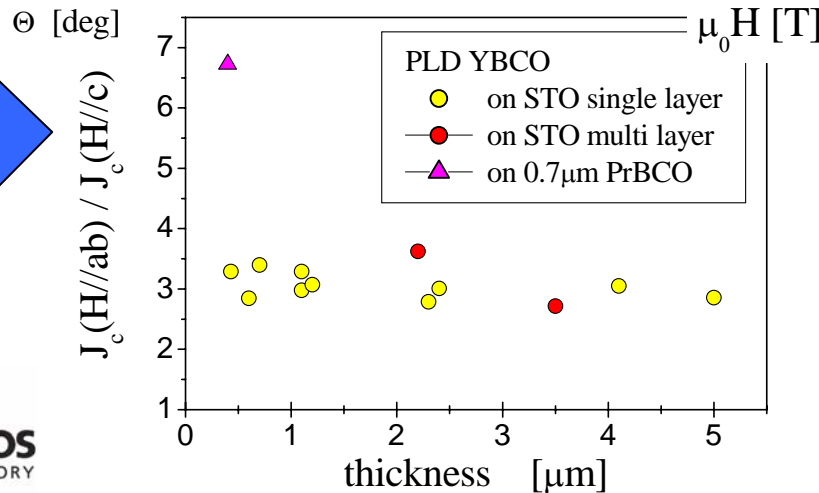
Last year's results



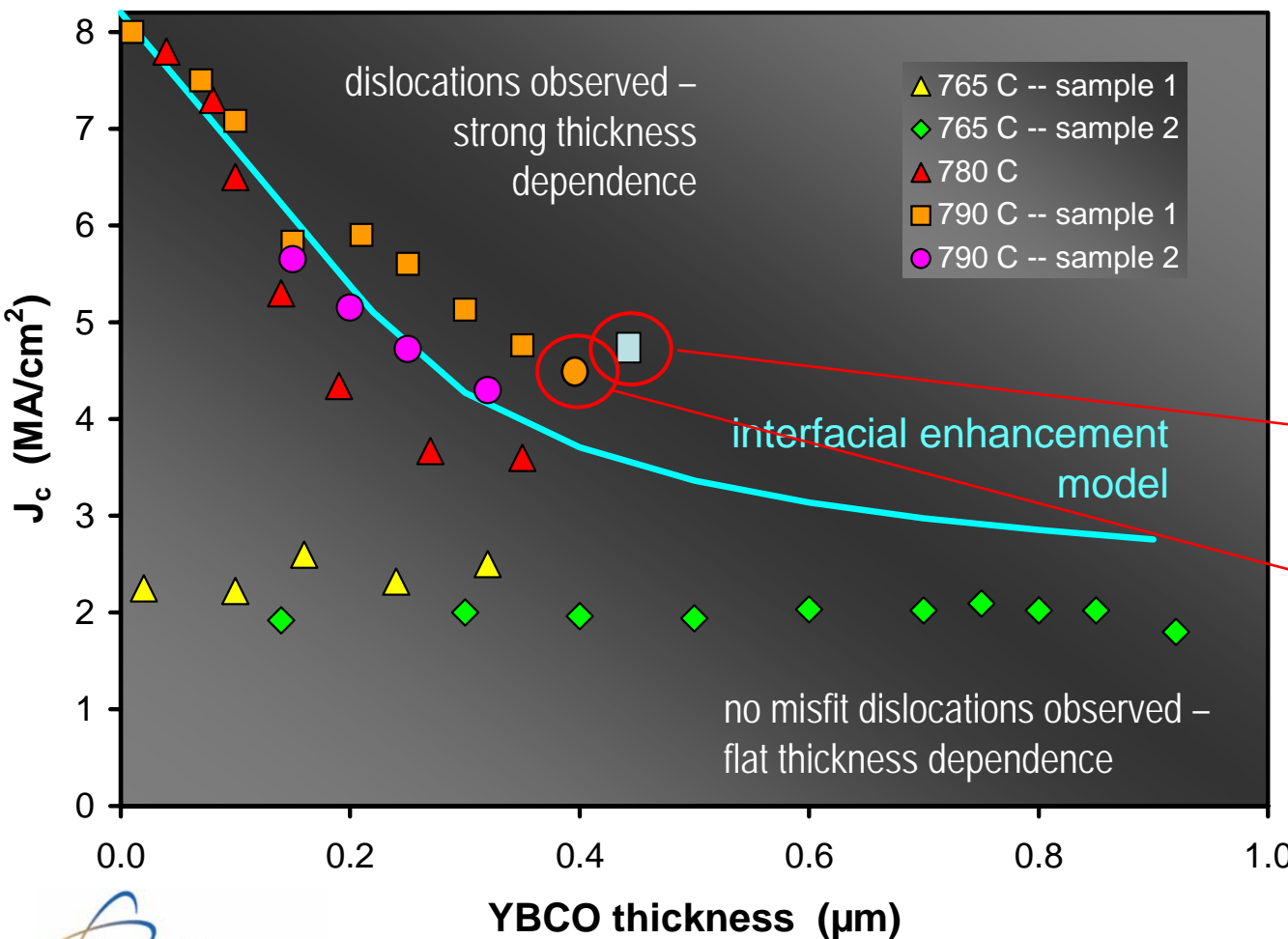
# The angular and field dependences of $J_c$ and $N$ of the $0.4\mu\text{m}$ thick film on a $0.7\mu\text{m}$ PrBCO layer *are* different



We have a new way to suppress the dislocations at the interface:  $\text{NdGaO}_3$  (NGO) substrates



# The NdGaO<sub>3</sub> substrates open the opportunity to compare films with and without misfit dislocations at the interface



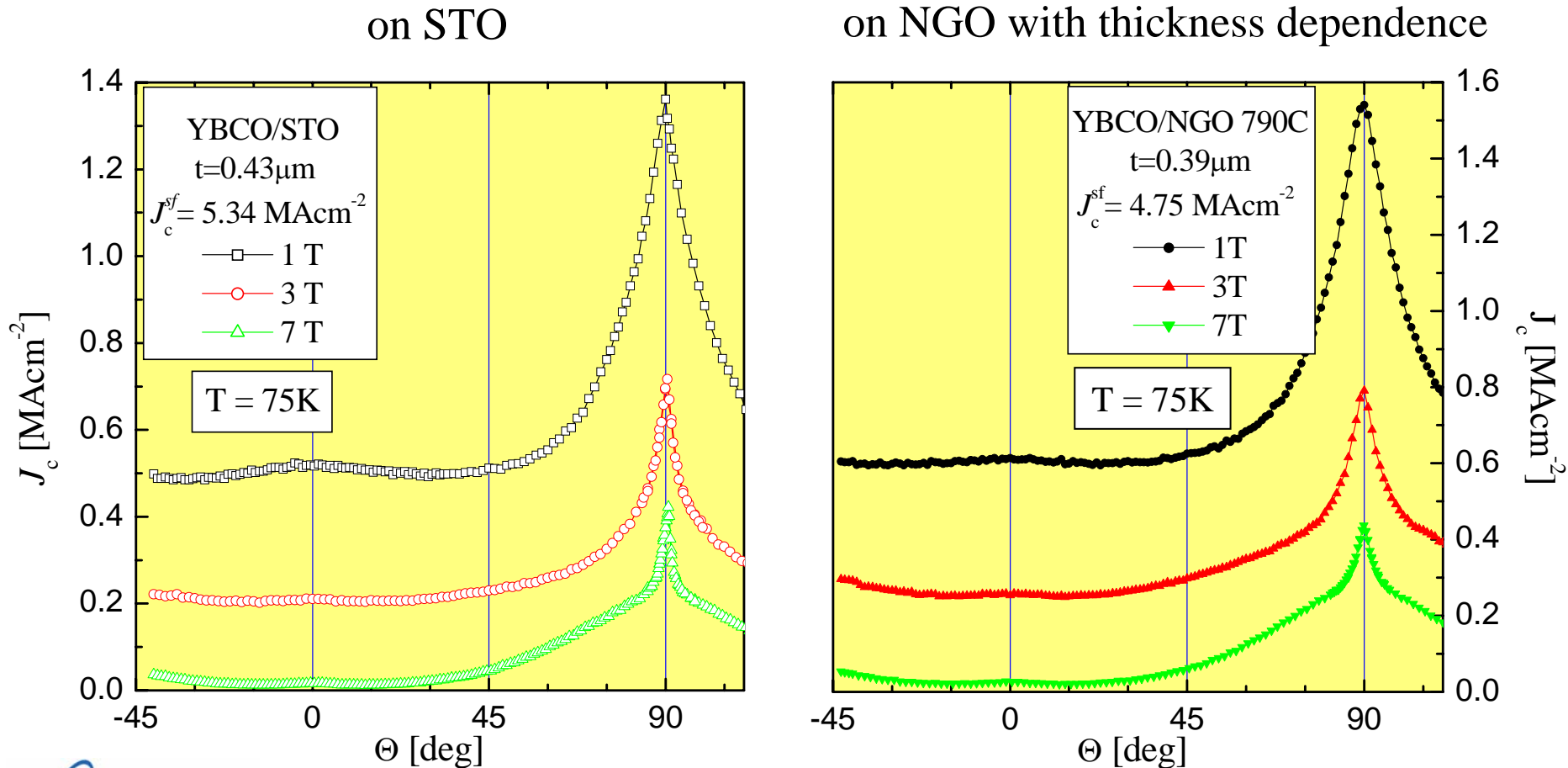
How similar are the pinning centers in films on STO and on NGO with interfacial enhancement?

on STO

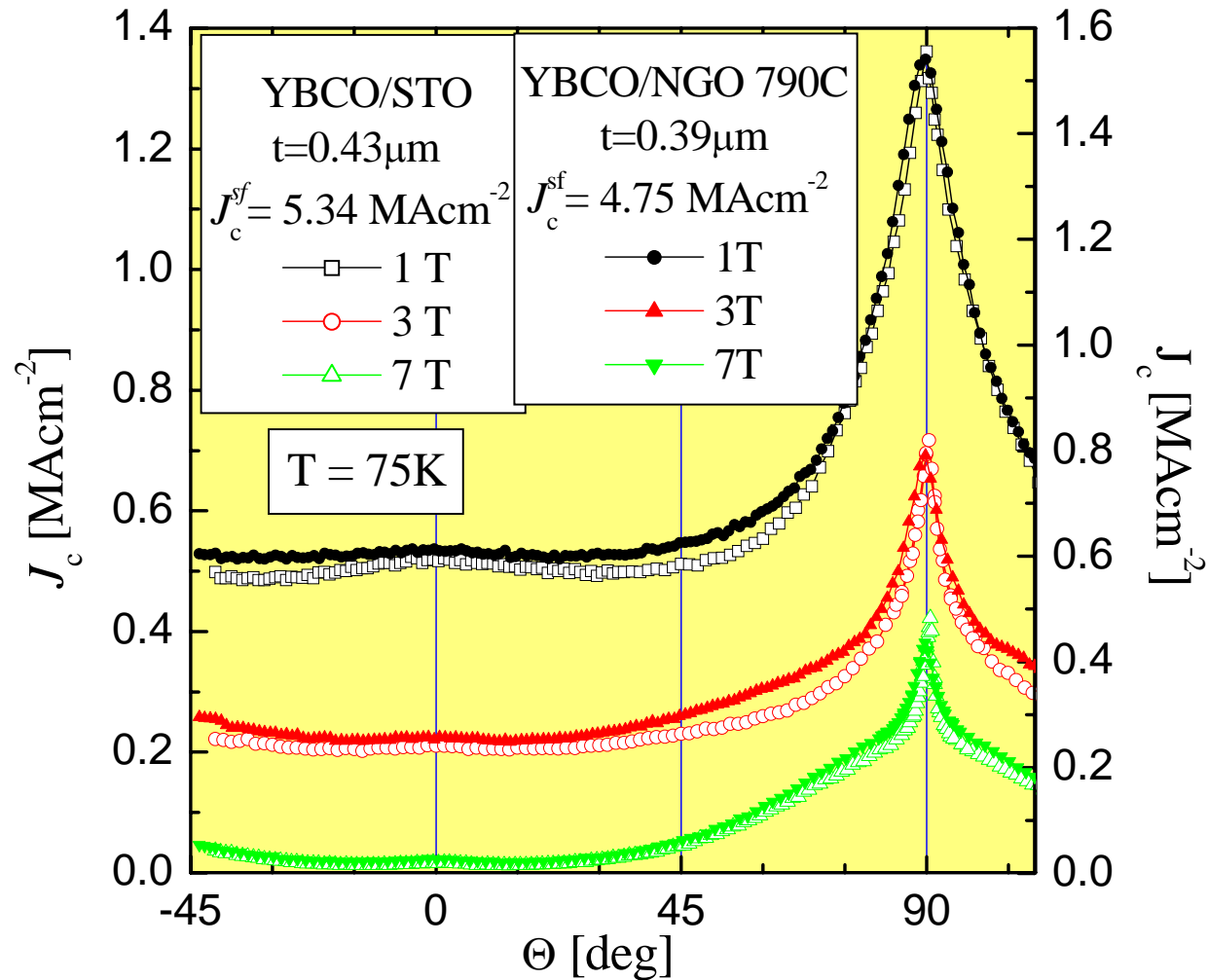
on NGO

Comparative study of two  $\sim 0.4\mu\text{m}$ -thick films, one on STO, and one on NGO (with dislocations)

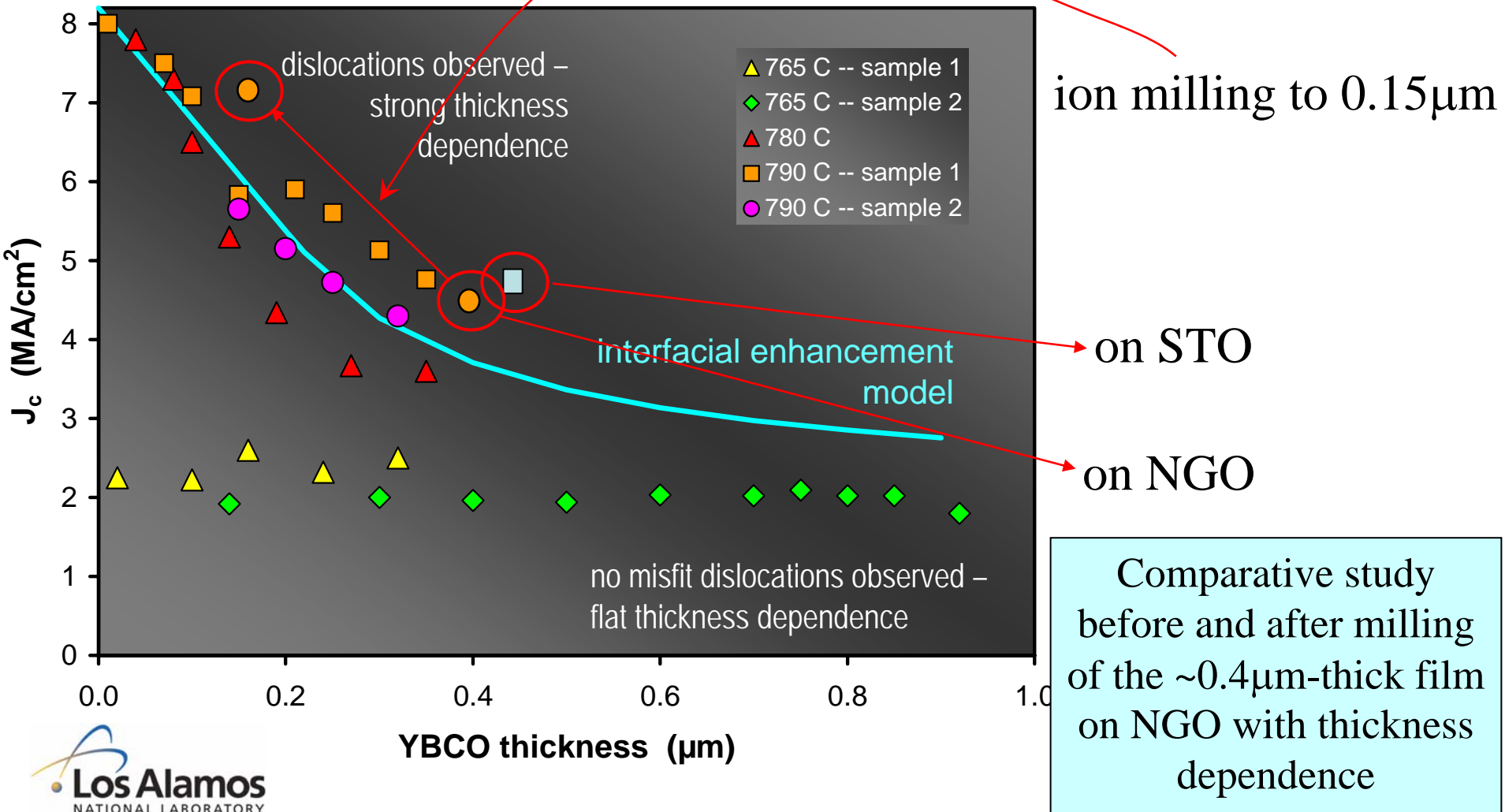
# “Validation” of the NGO: $J_c(H, \Theta)$ in both $\sim 0.4\mu\text{m}$ films (on STO and on NGO with interface dislocations) are the same



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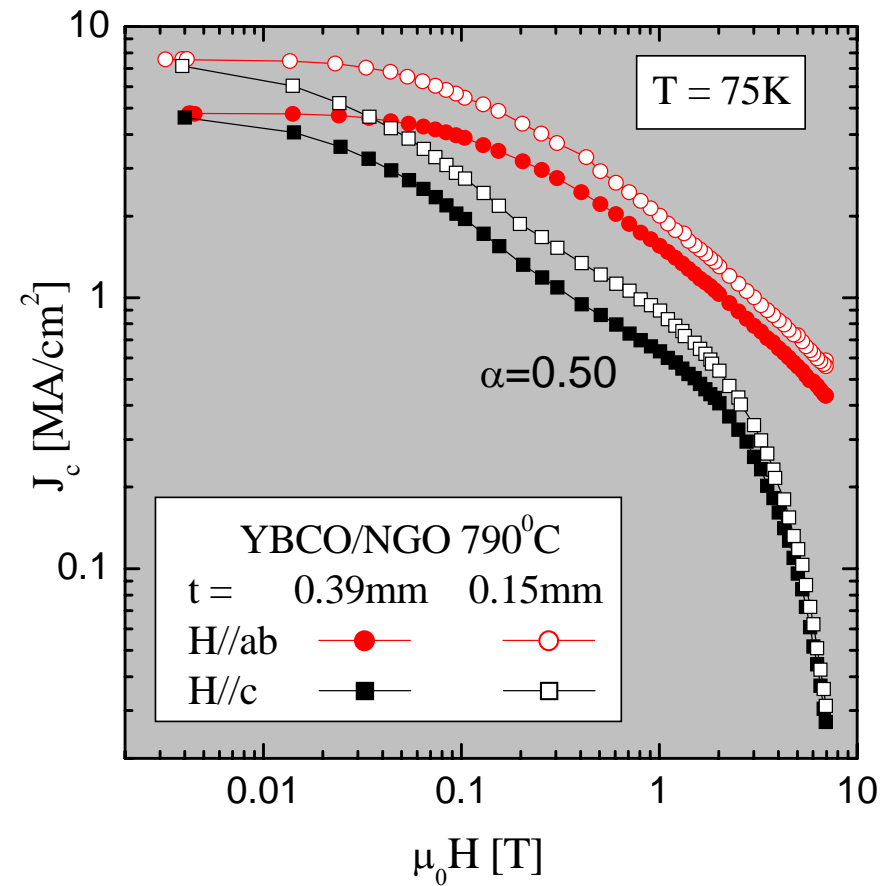
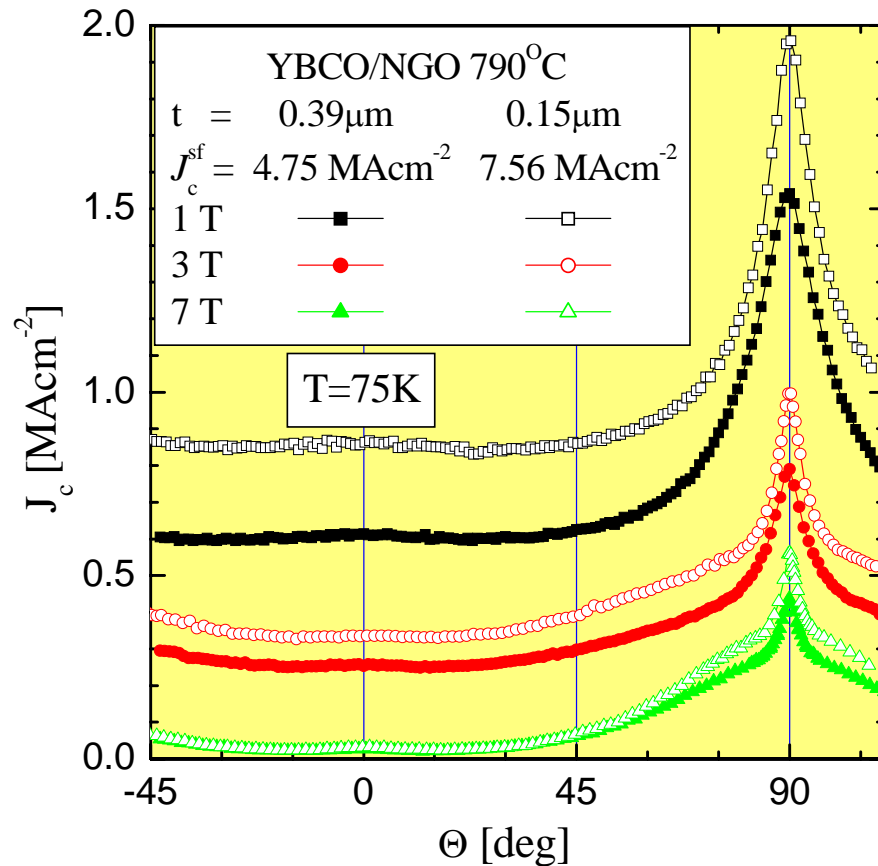


# Does the universal behavior extend to thinner films on NdGaO<sub>3</sub> substrates ?

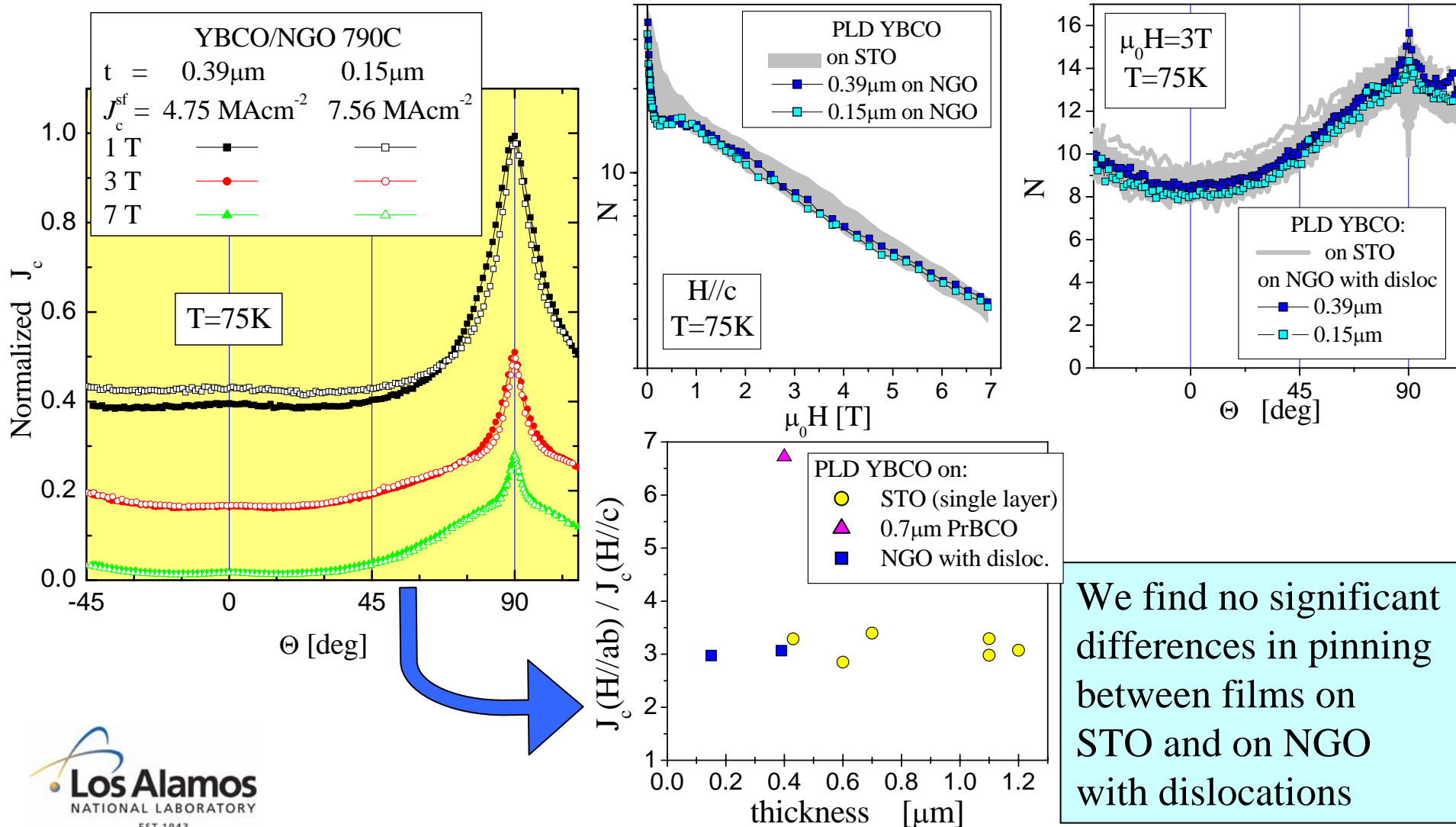




# The NGO film ion-milled to 0.15 $\mu\text{m}$ still retains the same angular and field dependence of $J_c$ and $N$

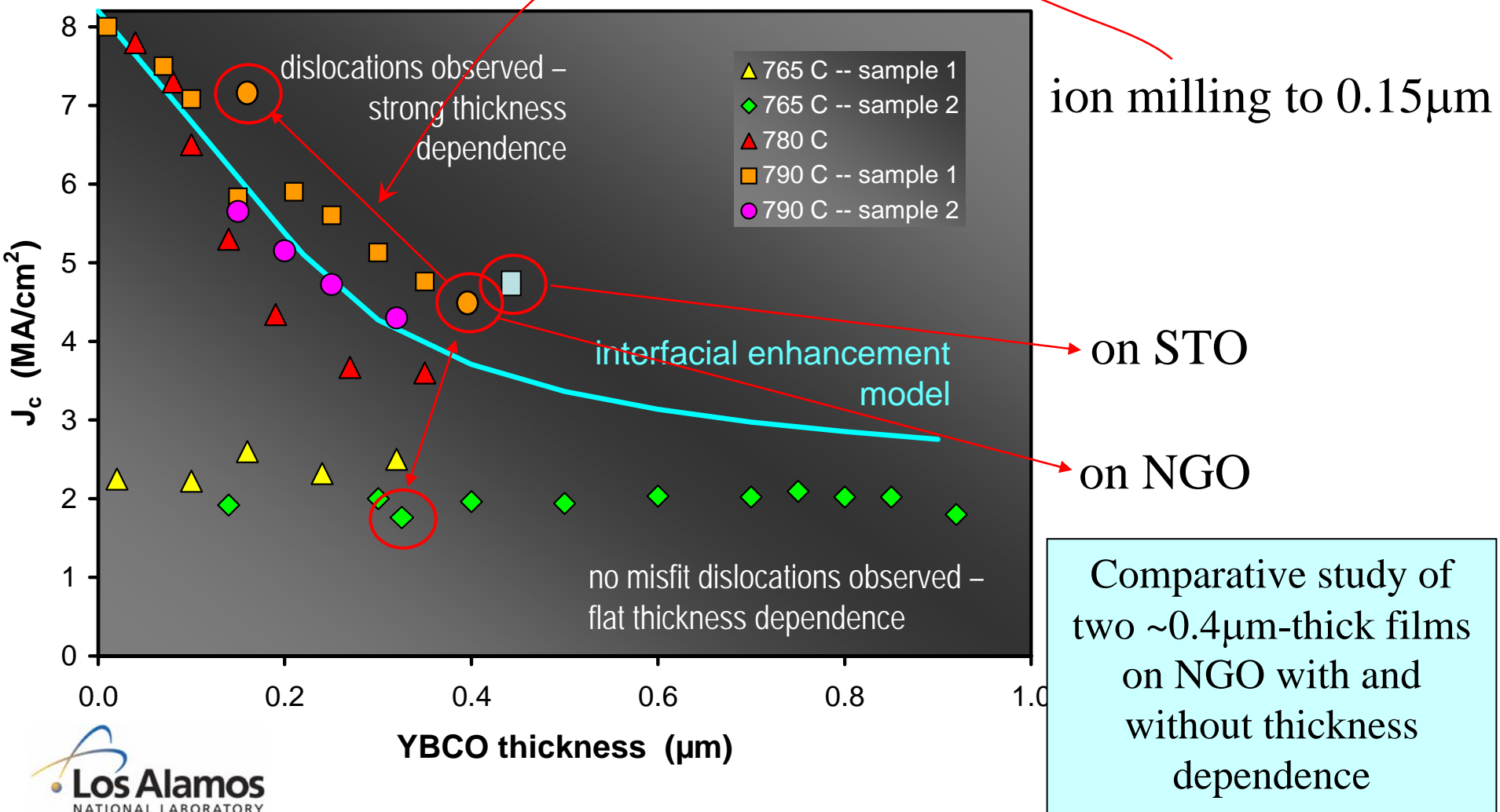


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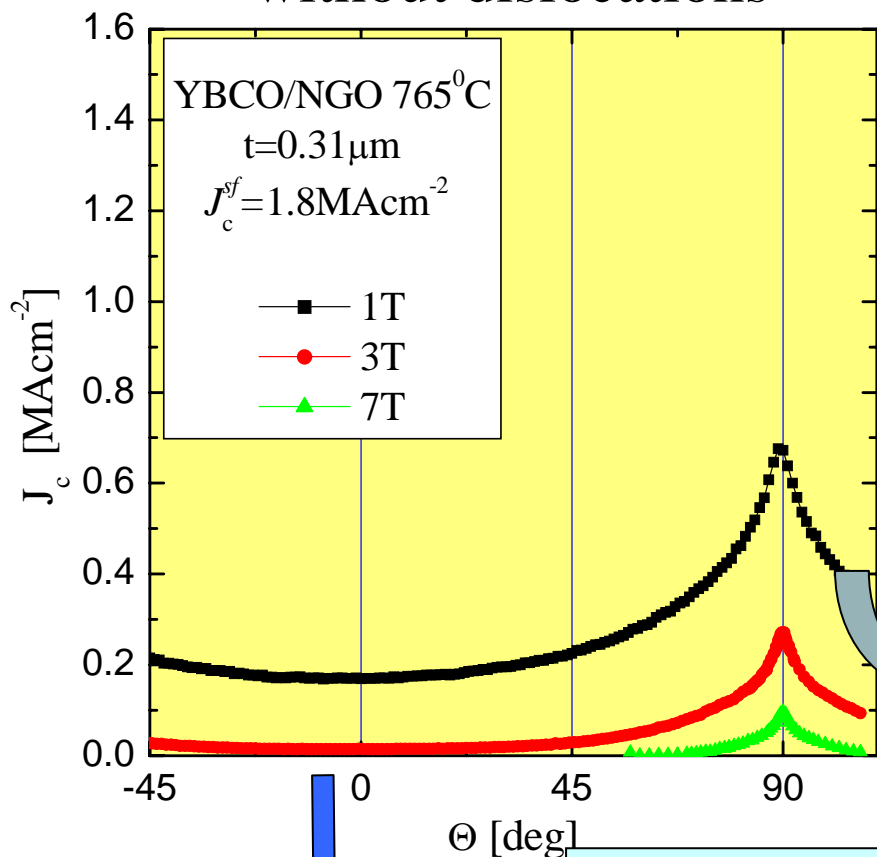
We find no significant differences in pinning between films on STO and on NGO with dislocations

# The $\text{NdGaO}_3$ substrates open the opportunity to compare films with and without misfit dislocations at the interface

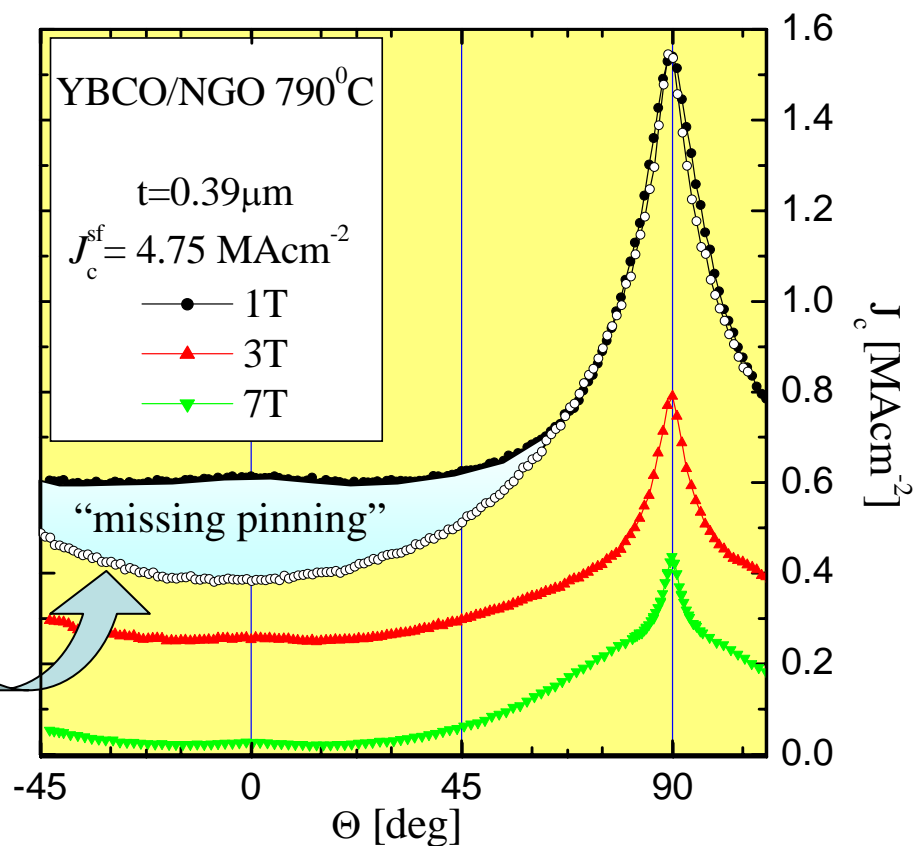


The film on NGO without interface dislocations not only has lower  $J_c(sf)$ , but also a very different shape of  $J_c(\Theta)$

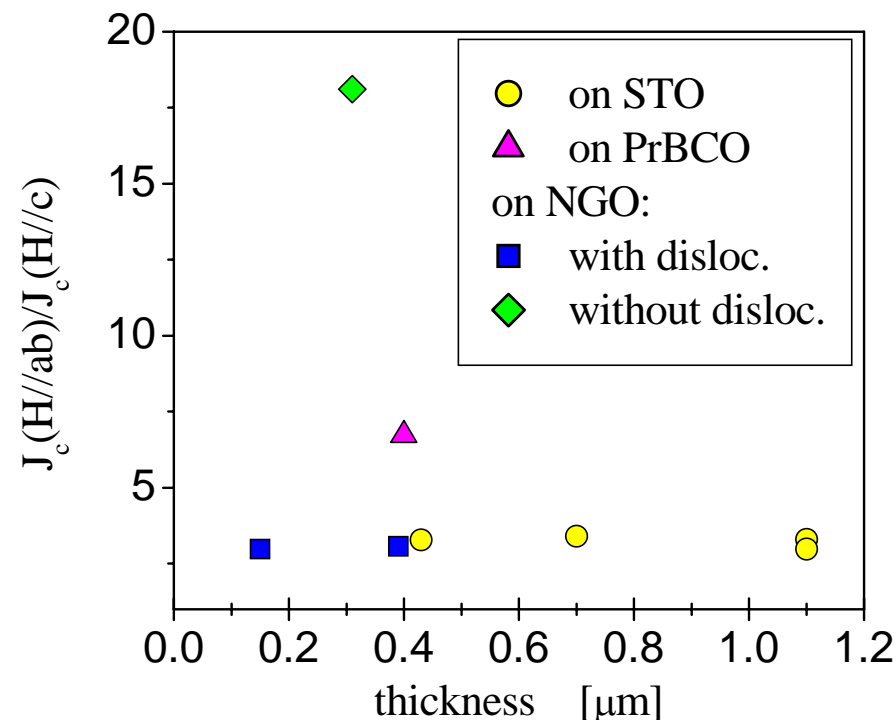
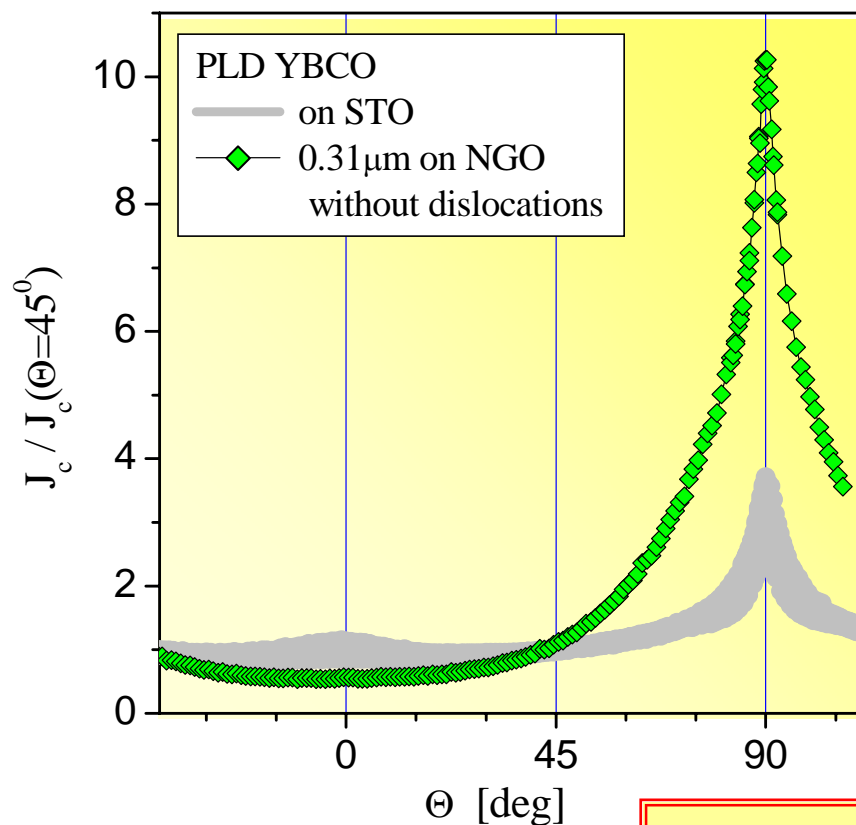
without dislocations



with dislocations

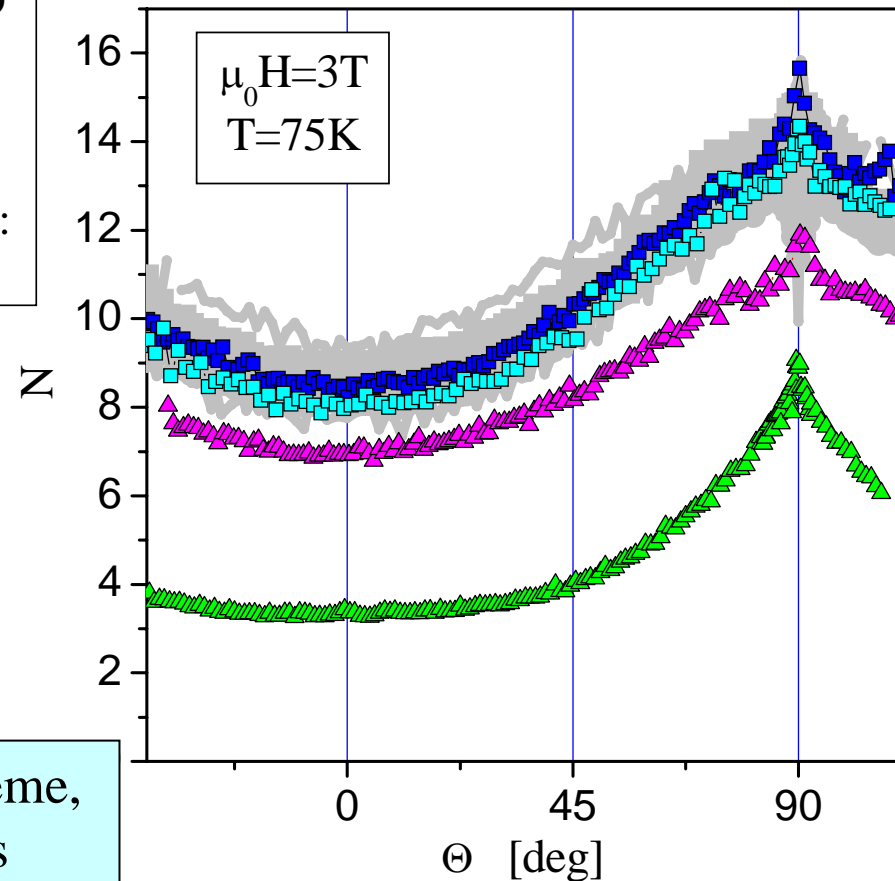
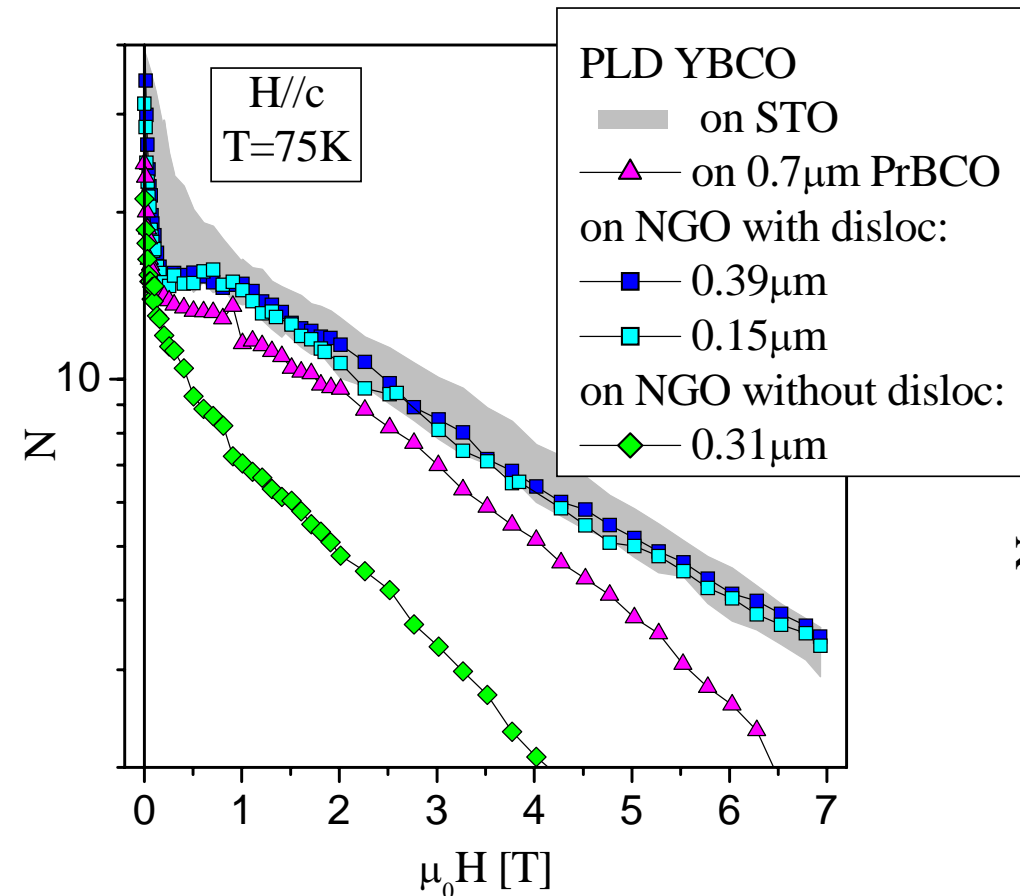


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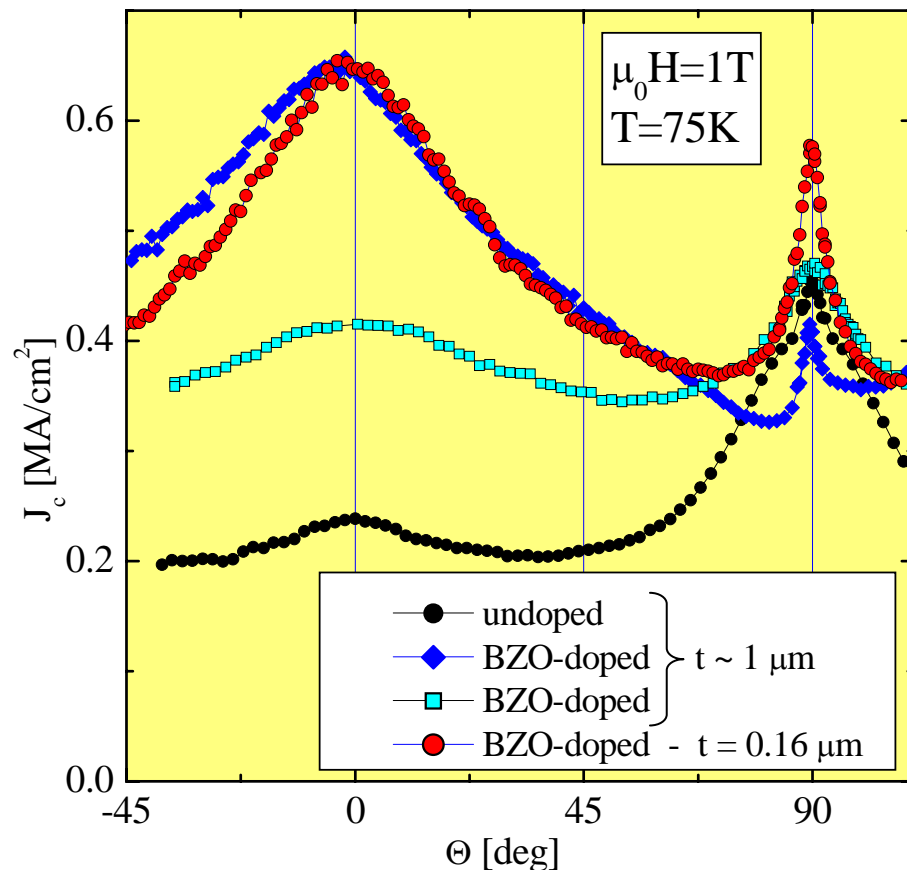
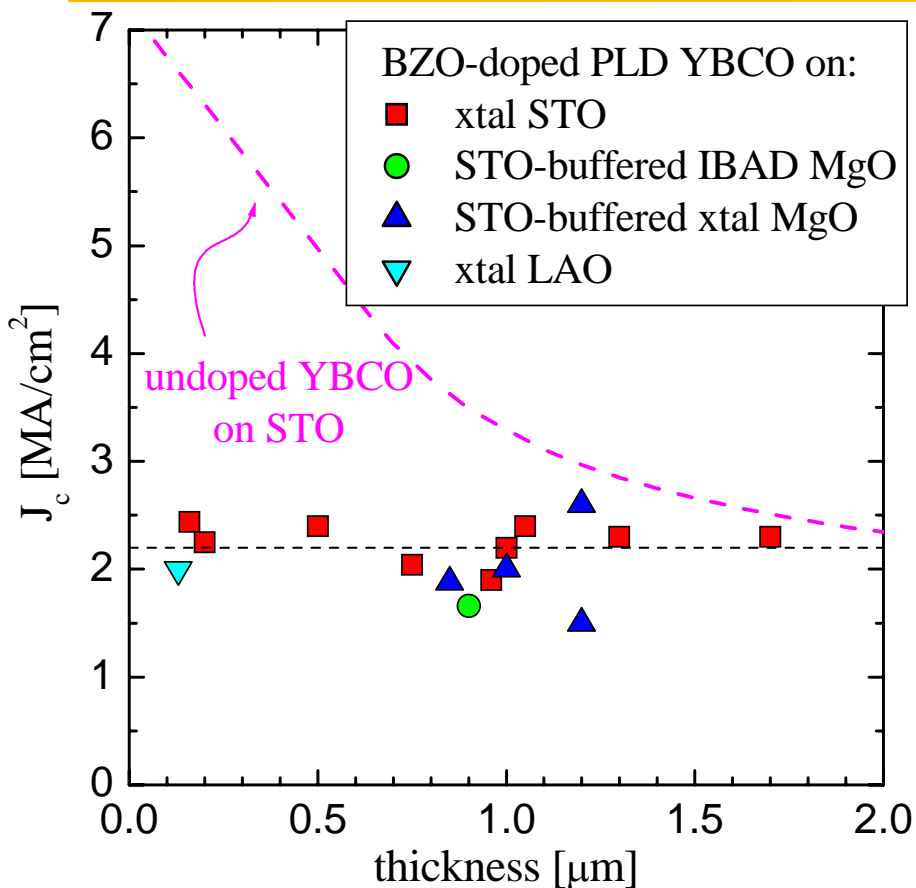
The very fast drop of  $J_c$  for  $H//c$  indicates low pinning by random defects, which have lower irreversibility line than correlated defects.

# The much lower N values in the NGO film without misfit dislocations also confirms the low pinning energy



Similar trend, but more extreme,  
than films on PrBCO spacers

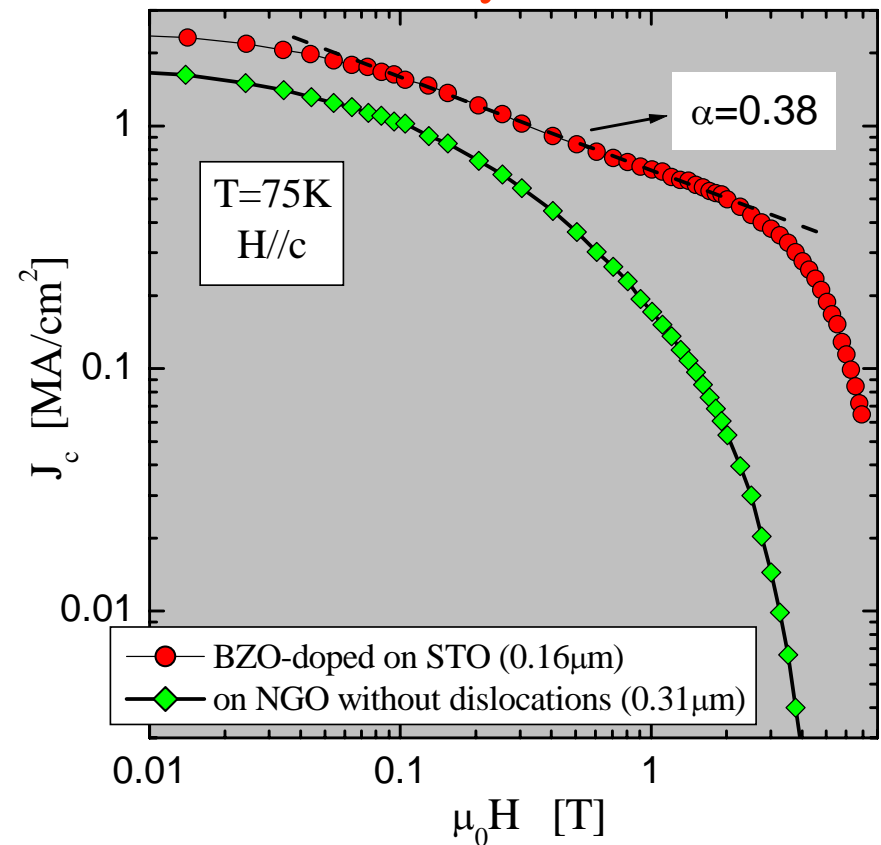
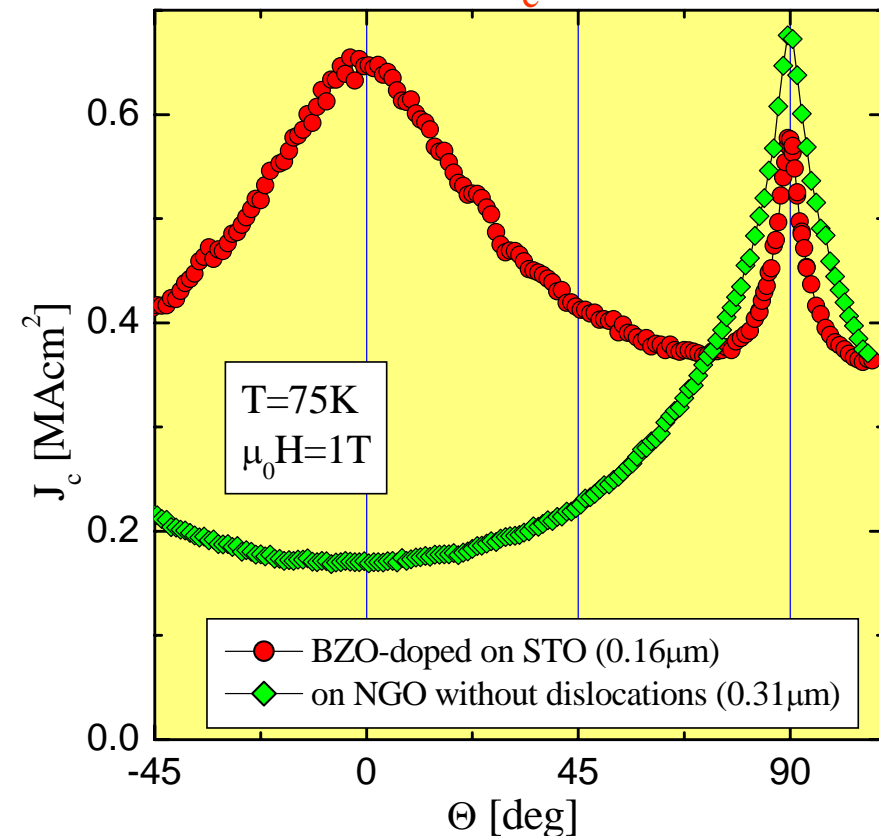
The  $J_c(sf)$  of our BaZrO<sub>3</sub> (BZO) doped films has *no thickness dependence*, however...



...even films thinner than 0.2 $\mu$ m exhibit a huge c-axis peak !

BZO-doped films and (undoped) films on NGO without interface dislocations have in common the absence of thickness dependence and similar  $J_c(sf)$  values, but...

...the in-field  $J_c$  of the BZO-doped films is dramatically better

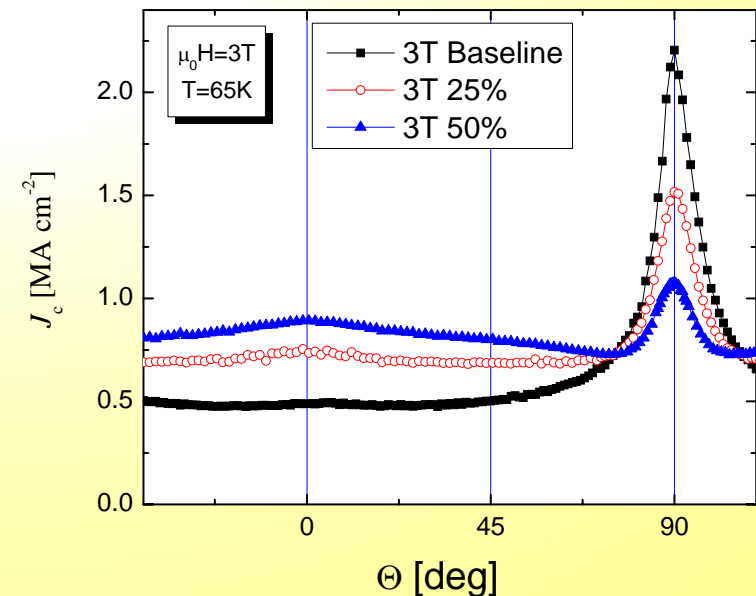
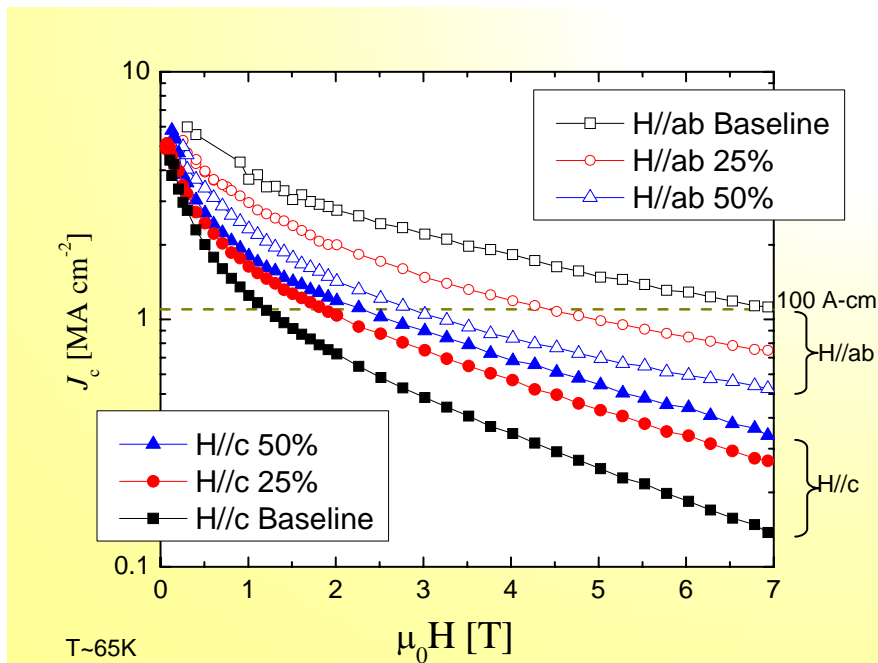




Substantial improvements for  $J_c(H//c)$  were found for  $\text{Er}_2\text{O}_3$  additions up to the level of 50% ( $\text{Y}_1\text{Er}_{0.5}\text{Ba}_2\text{Cu}_3\text{O}_y$ ).

- ❖ Little effect on  $J_c(\text{self-field})$
- ❖ Overall increase in  $J_c(H//c)$  at the expense of  $J_c(H//ab)$
- ❖ What are the changes in the pinning microstructure?

		$\underline{I_c}(\text{sf}, 75\text{K})$
Baseline	$(\text{Y}_1\text{Ba}_2\text{Cu}_3\text{O}_y)$	= 250 A/cm
25%Er	$(\text{Y}_1\text{Er}_{0.25}\text{Ba}_2\text{Cu}_3\text{O}_y)$	= 260 A/cm
50%Er	$(\text{Y}_1\text{Er}_{0.5}\text{Ba}_2\text{Cu}_3\text{O}_y)$	= 260 A/cm

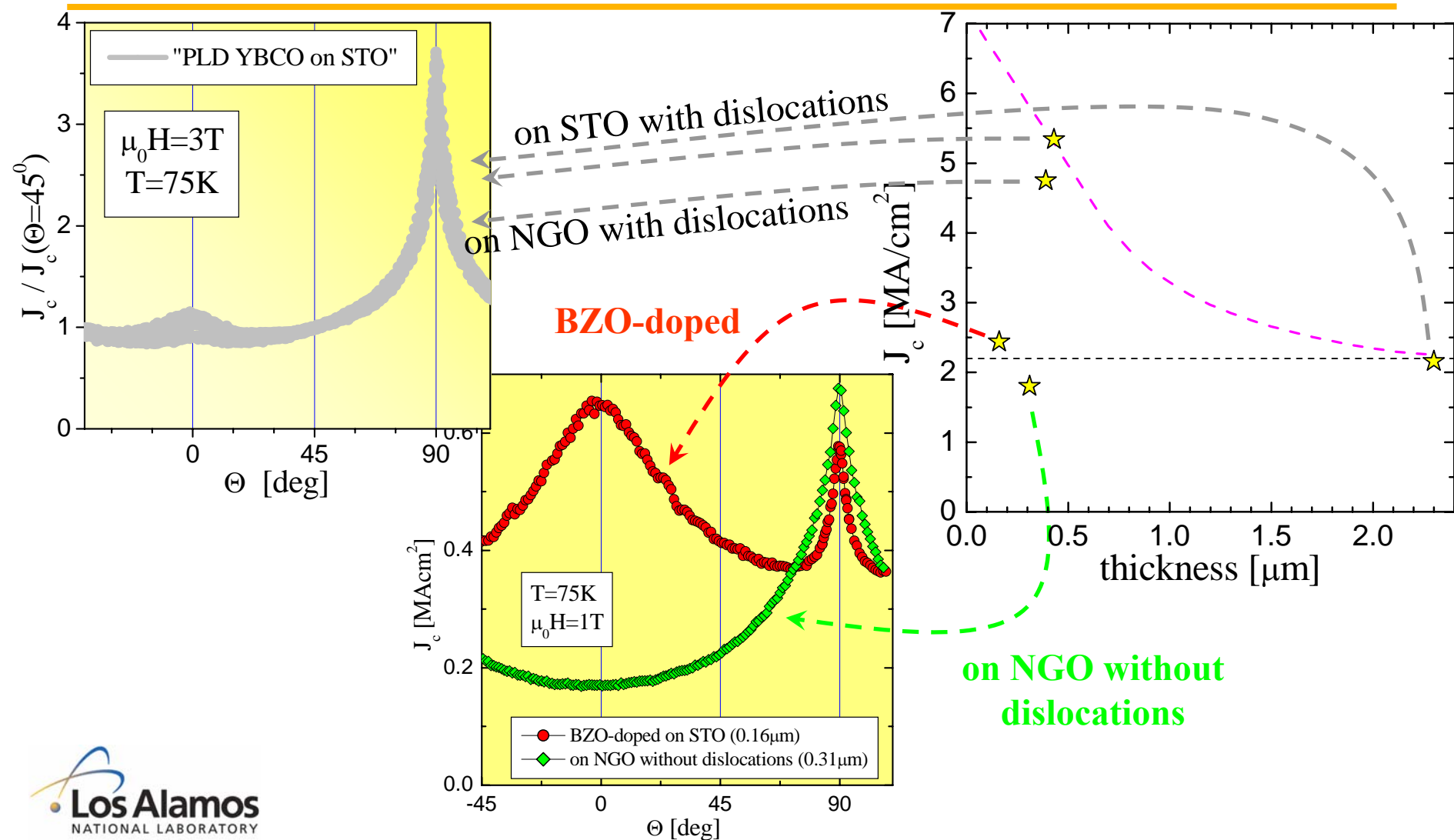


Same trends in  $J_c(H, \Theta)$  at 65K and 75K

Leonardo Civale and Boris Maiorov (LANL)

presented by T. Holesinger in the WDG talk at PR05

# Summary: We find universal $J_c(H, \Theta)$ behavior in PLD films with interface enhancement, but $J_c(H, \Theta)$ in films without enhancement is not unique



## *Scoring Criterion – Results*

1. Demonstrated that interfacial enhancement is responsible for strong thickness dependence and is consistent with most experimental observations of thickness dependence.
2. Established a definite link between interfacial misfit dislocations and thickness dependence.
3. Found two processing conditions for which thickness dependence is eliminated (low temperature YBCO on NdGaO<sub>3</sub> and BaZrO<sub>3</sub>-doped YBCO).
4. Established universal behavior of  $J_c(H, \Theta)$  for PLD YBCO single- and multi-layers on SrTiO<sub>3</sub> (xtal or buffer), over a wide thickness range.

## Scoring Criterion – Results (continued)

5. Studied  $H, \Theta$  dependence of exponent  $N$  of power law  $I$ - $V$  curves (associated with activation energy) – also found universal behavior.
6. Showed that  $J_c(H, \Theta)$  and  $N(H, \Theta)$  for films on  $\text{NdGaO}_3$  with thickness dependence follow the same behavior as films on  $\text{SrTiO}_3$ .
7. Determined that films on  $\text{NdGaO}_3$  and  $\text{PrBCO}$  without thickness dependence show different  $J_c(H, \Theta)$  and  $N(H, \Theta)$  behavior: faster decay with field, less pinning for field orientations near  $c$ -axis.
8. Moved to higher- $J_c$  multilayers, achieving 990 A/cm-width in a 2.2  $\mu\text{m}$  thick film.

## *Scoring criterion* – Research Integration

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- \* In 2006 we worked with SuperPower to demonstrate the compatibility of high-current multilayer technology with the MOCVD process, and engaged in characterization and analysis of flux pinning in MOCVD films (CRADA).
- \* Continued our participation in the Wire Development Group. We performed extensive structural and electrical characterization, and contributed to advancing the understanding of pinning enhancement methods. Developed new capabilities for long-length characterization (presented in Wire Session).
- \* We established a CRADA with AMBP Technologies to study a novel method for adding flux-pinning defects to YBCO.

## *Scoring criterion* – Research Integration (continued)

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- \* We collaborated with Argonne National Laboratory in the analysis of thickness dependence of cation disorder.
- \* We continued our long-standing collaboration with University of Cambridge in the area of flux-pinning enhancement and in the study of Hybrid Liquid Phase Epitaxy as an alternate YBCO deposition method.
- \* We continued our collaboration with the Applied Superconductivity Center at University of Wisconsin, Madison on flux-pinning studies (mutual visits, sample exchanges and joint presentations).
- \* We began a collaboration with the National High Magnetic Field Laboratory/Florida State University to study high-field vortex pinning and performance of coated conductors.

# Scoring Criterion – Performance

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**Plan:** Continue research into the cause of elevated  $j_c$  near the interface.

*Goal: Understand the 0.65  $\mu\text{m}$  range of influence.*

## Accomplishments:

- Established conclusively that thickness dependence arises from interfacial enhancement.
- Showed that interfacial enhancement and misfit dislocations are strongly correlated
- Found a way to change the 0.65  $\mu\text{m}$  range of influence...or eliminate it altogether.
- Used angular and field dependence to demonstrate universal behavior for PLD films with strong thickness dependence from 0.15 – 5  $\mu\text{m}$  thickness.
- Showed a different behavior for films on  $\text{NdGaO}_3$  and  $\text{PrBCO}$  that have no thickness dependence.

## Scoring Criterion – Performance (continued)

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**Plan:** Survey alternate interlayer or buffer layer materials.

*Goal: Determine which properties are significant in producing high interfacial  $j_c$ .*

### Accomplishments:

- Determined that lattice mismatch is an important property by showing that multilayers using  $\text{CeO}_2$  or  $\text{Y}_2\text{O}_3$  interlayers have significantly elevated  $J_c$ , while ones using small-mismatch interlayers (SmBCO, PrBCO) do not.
- Demonstrated strong interfacial enhancement occurs when the mismatch between buffer layer and *either* YBCO axis is 1.7 – 2.4 %.
- Proved that interfacial enhancement (and thickness dependence) can be eliminated if lattice mismatch is sufficiently reduced.



## *Scoring Criterion – Performance (continued)*

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**Plan:** Push the practical limit to thick-film  $I_c$  that can be achieved by depositing a greater number of thinner YBCO layers.

*Goal: 1000 A/cm-width in a 2  $\mu\text{m}$  film.*

**Accomplishment:**

- 990 A/cm-width at 2.2  $\mu\text{m}$ .

## Scoring Criterion – Performance (continued)

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**Plan:** Combine multilayers with an in-field pinning enhancement method.

*Goal: self-field  $I_c = 1000$  A/cm-width and  $\alpha < 0.4$ .*

### Accomplishments:

- Made multilayers using BaZrO<sub>3</sub>-doped YBCO and found that there was no improvement over a single-layer of the same total thickness.
- To diagnose, checked the thickness dependence of BaZrO<sub>3</sub>-doped YBCO and found that it is very weak, or absent.
- Hypothesized that weak thickness dependence arises because the BaZrO<sub>3</sub> particles provide an alternate means to relieve interfacial stress, or otherwise interrupt the formation of misfit dislocations.

## Scoring Criterion – Performance (continued)

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**Plan:** Work closely with SuperPower to produce high-current multilayers on IBAD MgO using MOCVD.

*Goal: Significant improvement over single-layer  $I_c$ s.*

### Accomplishment:

- Demonstrated the feasibility of using the multilayer approach with MOCVD, especially in concert with SuperPower's multipass method. Incremental improvement was realized, but was overshadowed by substantial progress in single-layer  $J_c$  at SuperPower.
- This effort will continue in FY 2007.

## *Scoring Criterion – Performance (continued)*

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**Plan:** Continue to work with American Superconductor in the understanding and enhancement of vortex pinning in ex-situ films.

*Goal: To be coordinated with AMSC.*

### **Accomplishment:**

- Our work in this area was described in the Wire Development Group presentation to the Joint Panel, and in the presentation by Holesinger and Civale in the Wire Session.

# *Scoring Criterion – FY 2007 Plans*

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Pursue the link between interfacial defects and thickness dependence to determine the source of interfacial enhancement of  $J_c$ :

- Establish a collaboration to theoretically examine the film stresses leading to formation of misfit dislocations, and the nature of the dislocations themselves.
- Design experiments to systematically change film stresses and measure the effect on thickness dependence.
- Conduct microscopic examinations of films to illuminate the nature and extent of defects present in the interfacial region.
- In combination with microscopic examination, use field and angular dependence to identify the defects responsible for both thickness dependence and in-field pinning improvement.

## *Scoring Criterion – FY 2007 Plans (continued)*

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- \* Find the reason for flat thickness dependence in  $\text{BaZrO}_3$ -doped YBCO films.
- \* Use the above result to find an in-field pinning enhancement method compatible with high-current multilayers.